

# Radiation Stability of Multilayer Structures

Gary S. Was  
University of Michigan

US Fusion Materials Science Program  
Strategic Planning Meeting

University of California at Santa Barbara  
August 26-30, 2002



# What is the composition and phase stability of multilayer structures under irradiation?

- Interface mixing
  - recoil implantation
  - displacement (cascade) mixing (DM)
  - radiation enhanced diffusion (RED)
  - radiation induced segregation (RIS)
- Phase stability
  - phase separation
  - phase formation
- Irradiation of multilayers
- Synthesis of multilayers



## Displacement Mixing

In the atomistic model of thermal diffusion:

$$D = 1/6 \lambda^2 \Gamma,$$

$\lambda$  = jump length,  $\Gamma$  = jump frequency.

The transport under irradiation is characterized by an effective diffusion coefficient:

$$D^* = 1/6 R^2 F$$

$R$  = root-mean square displ. of an atom in the collision cascade,  
 $F$  = atomic displacement rate in dpa/s.

$F$  is estimated from the K-P displacement model:

$$F = \frac{dE/dx|_n \phi}{4 E_{d,\min} N}$$



$$\text{yielding } D^* = \frac{R^2 \left. \frac{dE}{dx} \right|_n \phi}{24 E_{d,\min} N}$$

$$\text{Fick's 2nd law: } \frac{\partial C}{\partial t} = -\nabla \cdot D \nabla C = -D \nabla^2 C \quad \text{for } D \neq f(C)$$

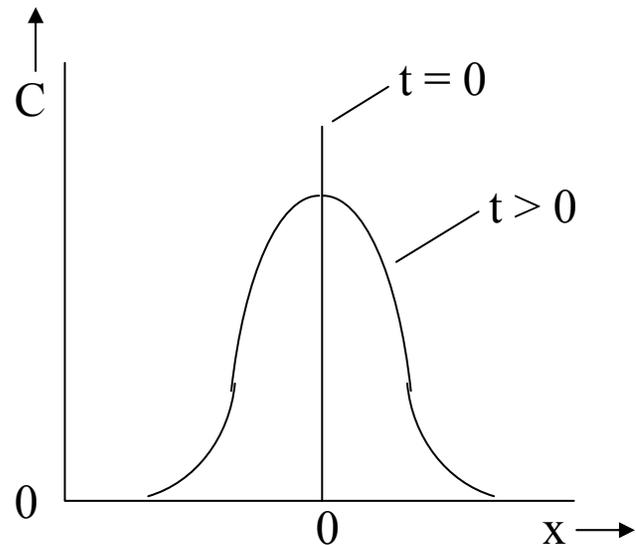
### Thin film solution

for  $|x| > 0$ ,  $C \rightarrow 0$  as  $t \rightarrow 0$

for  $x=0$ ,  $C \rightarrow 1$  as  $t \rightarrow 0$

$$\text{and } \int_{-\infty}^{\infty} C(x, t) dx = \alpha$$

$$C(x, t) = \frac{\alpha}{\sqrt{4\pi Dt}} \exp\left(\frac{-x^2}{4Dt}\right)$$



variance,  $\sigma^2 = 4Dt$

std. deviation,  $\sigma = (4Dt)^{1/2}$

FWHM =  $2.35 \sigma$



So, given the expression for  $D^*$ , the increment of FWHM due to cascade mixing is:

$$\Delta\text{FWHM} = 2.35\sqrt{4D^* t} \cong 5R \left[ \frac{dE/dx|_n \phi t}{24E_{d,\min} N} \right]^{1/2}$$

Note that broadening is proportional to  $(\phi t)^{1/2}$



## Example

What dose of 150 keV Kr<sup>+</sup> on Ni marker in Al is required to produce a  $\Delta$ FWHM of 10 nm?

$$\Delta\text{FWHM} = 10\text{nm} = 5R \left[ \frac{dE/dx|_n \phi t}{24E_{d,\min}N} \right]^{1/2}$$
$$\Delta\text{FWHM} = 10\text{nm} = 5R \left[ \frac{\sigma \bar{T}(\phi t)}{24E_{d,\min}} \right]^{1/2}$$

For  $dE/dx|_n = N\sigma_s T$

$$\sigma \sim 10^{-16} \text{ cm}^2$$

$$\sigma T \sim E_0 = 150 \text{ keV}$$

$$\sigma E_{d,\min} \sim 15 \text{ eV}$$

$$R \sim 1.5 \text{ nm}$$

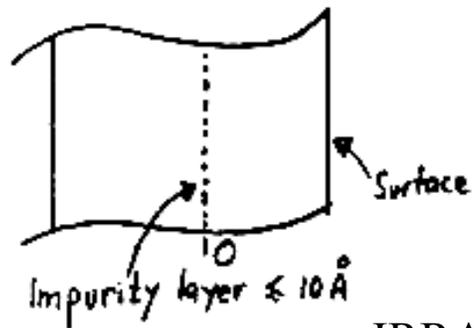
then  $\phi t = 6 \times 10^{14} \text{ i/cm}^2$  for 150 keV Kr<sup>+</sup>

for He<sup>+</sup> at 150 keV,  $\phi t = 2.5 \times 10^{15} \text{ i/cm}^2$

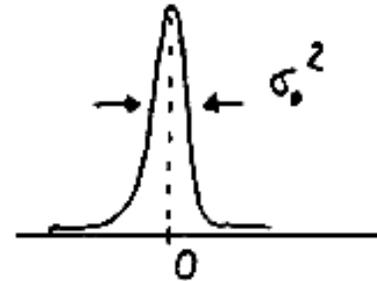


# Marker Layer Experiments

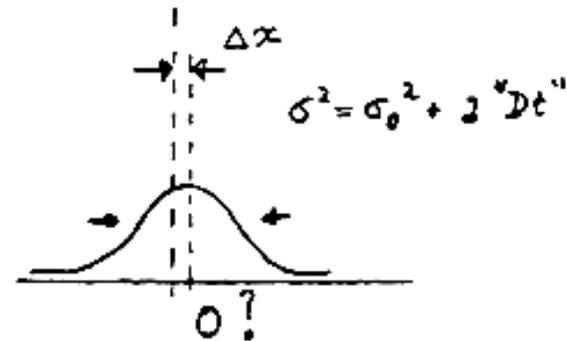
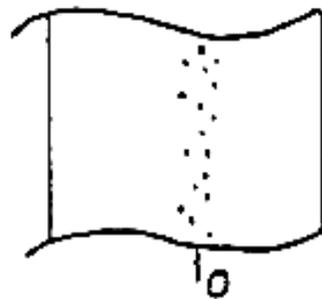
Sample



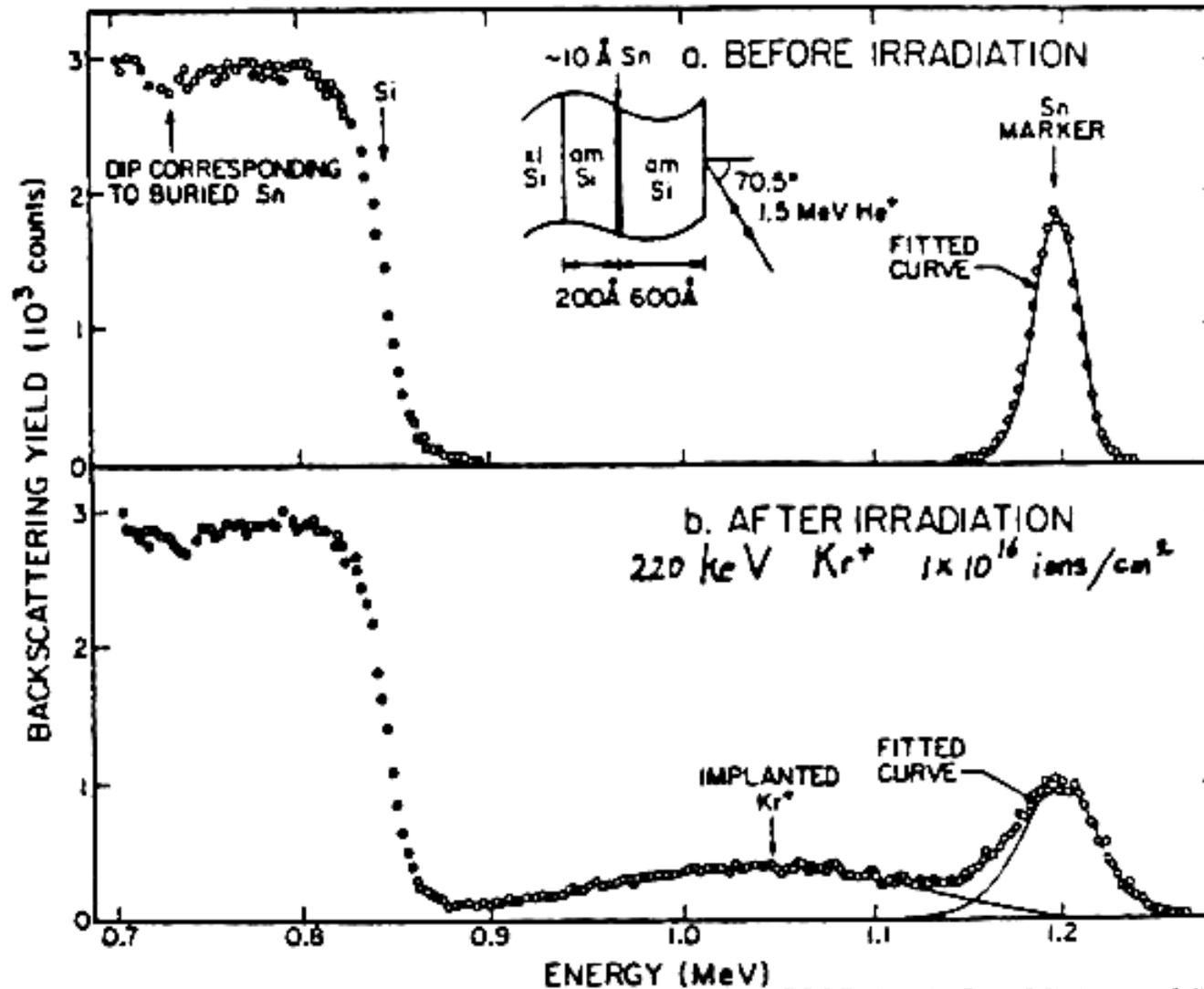
Impurity profile



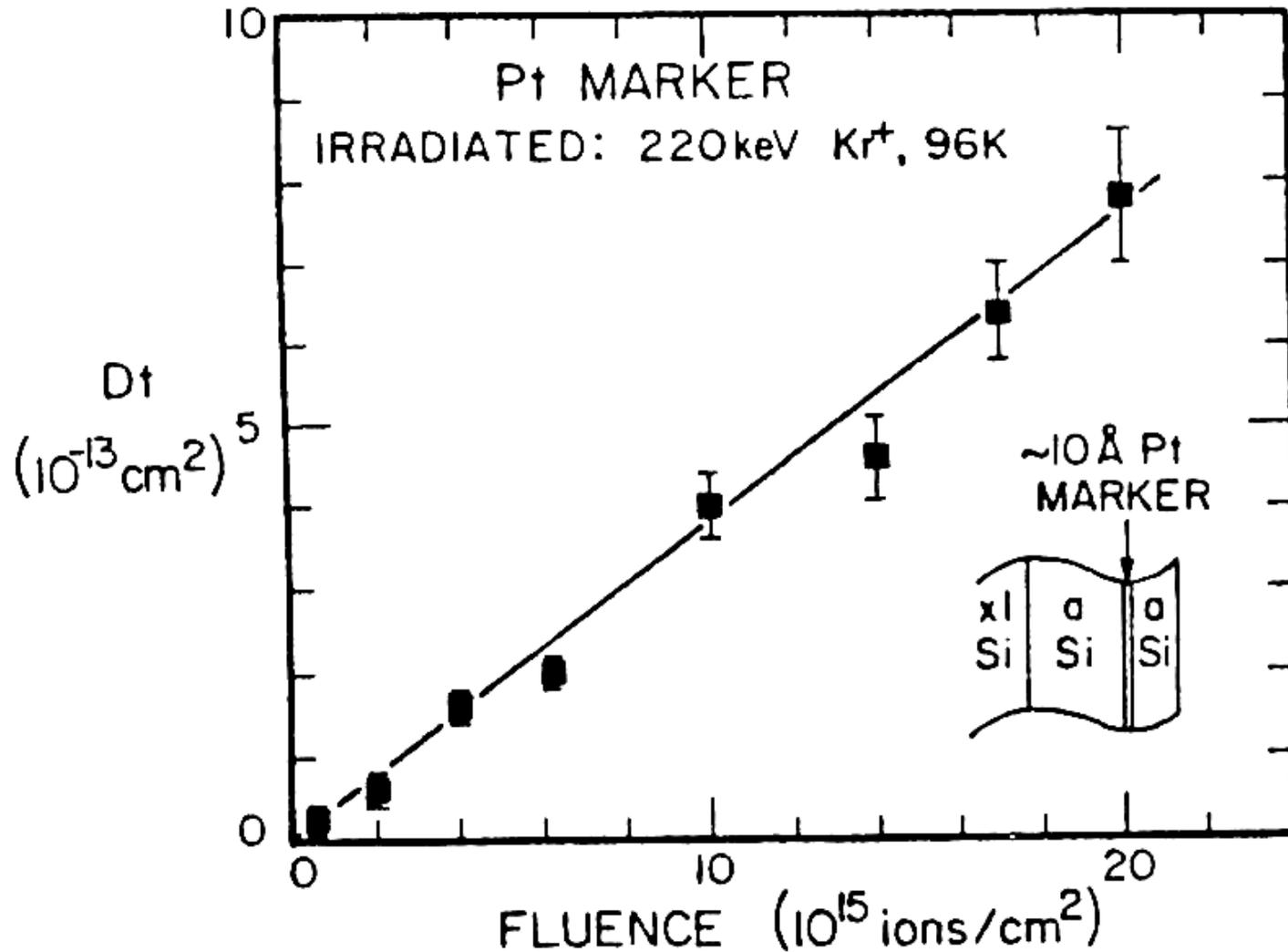
IRRADIATION



# Marker Broadening - Rutherford Backscattering Spectra

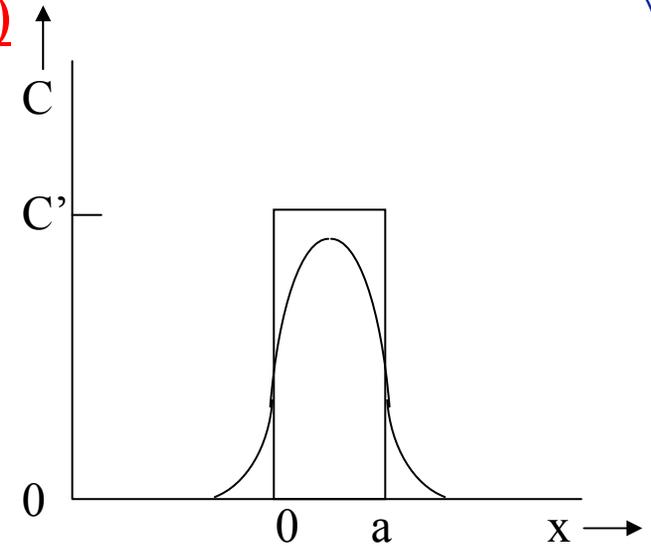


# Fluence dependence of marker broadening



## Thin film of finite thickness (multilayer)

B.C.  $C = C'$  for  $0 < x < a$ ,  $t = 0$   
 $C = 0$  for  $x < 0$ ,  $x > a$  at  $t = 0$



$$C(x, t) = \frac{C'}{2} \left[ \operatorname{erf}\left(\frac{x}{\sqrt{4Dt}}\right) - \operatorname{erf}\left(\frac{x-a}{\sqrt{4Dt}}\right) \right]$$

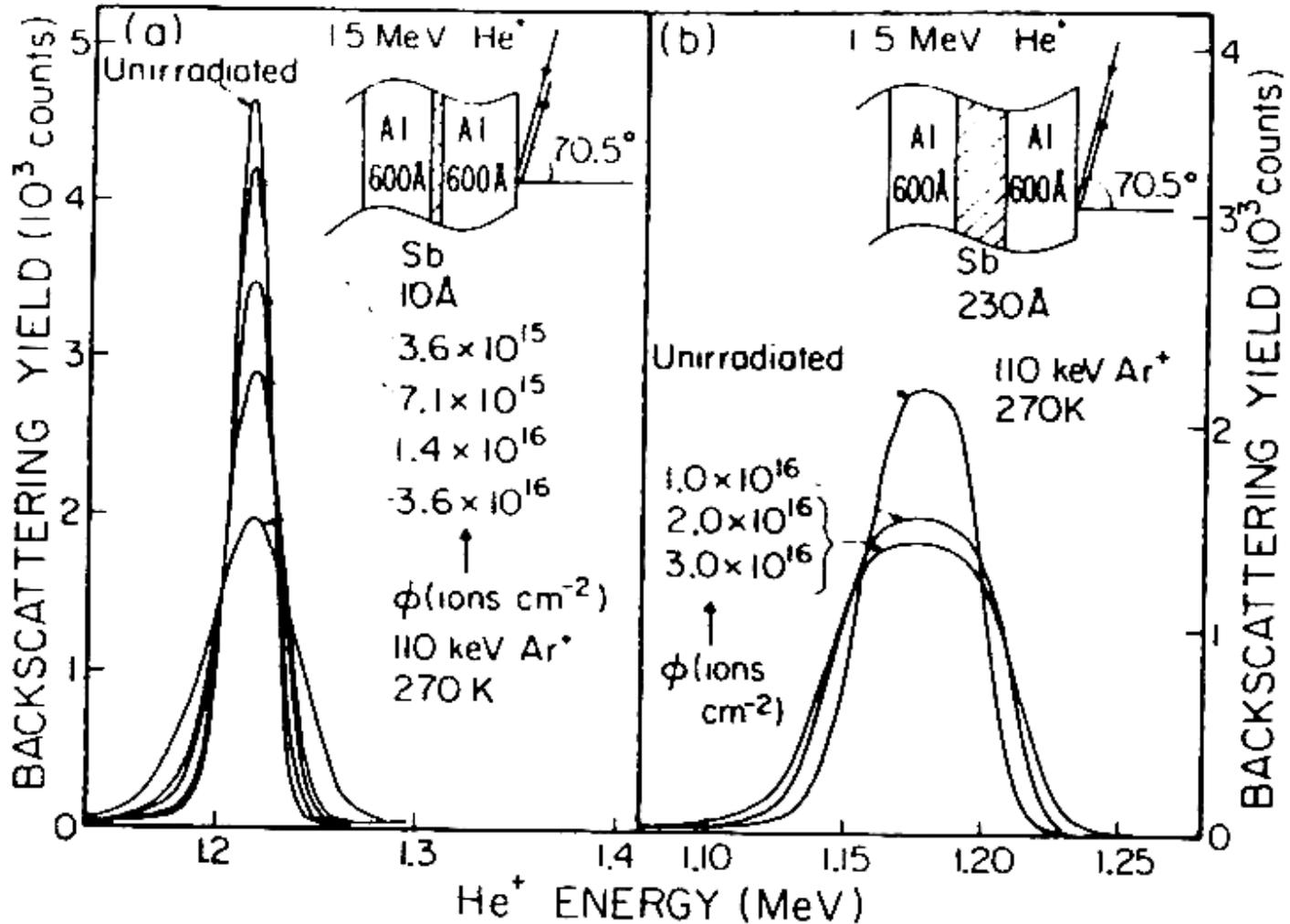
In terms of experimentally measured spectra,

$$\sigma_{\text{total}}^2 = \sigma_{\text{unirrad}}^2 + \sigma_{\text{mixing}}^2$$

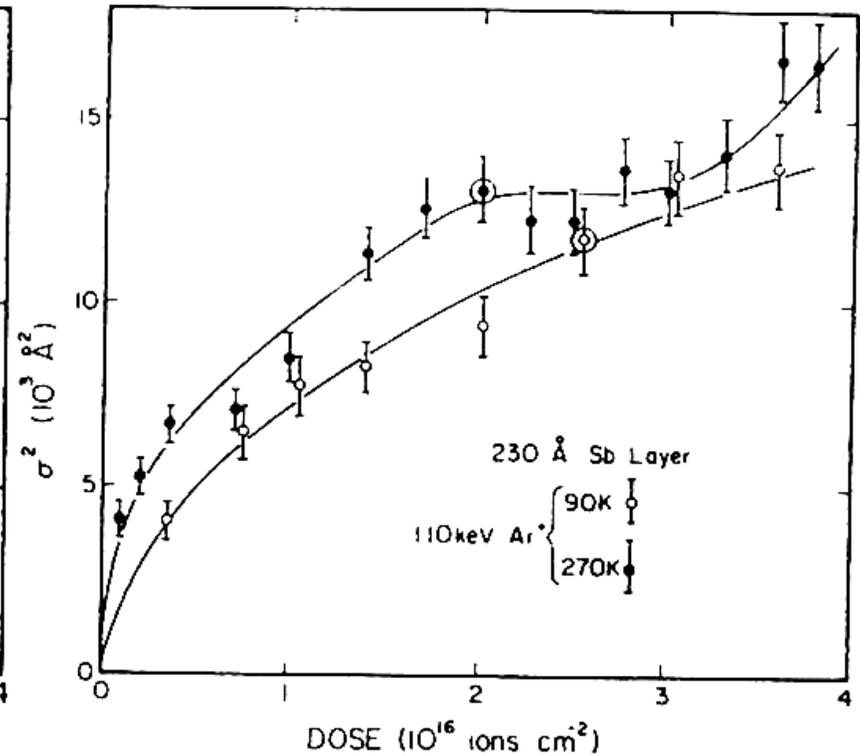
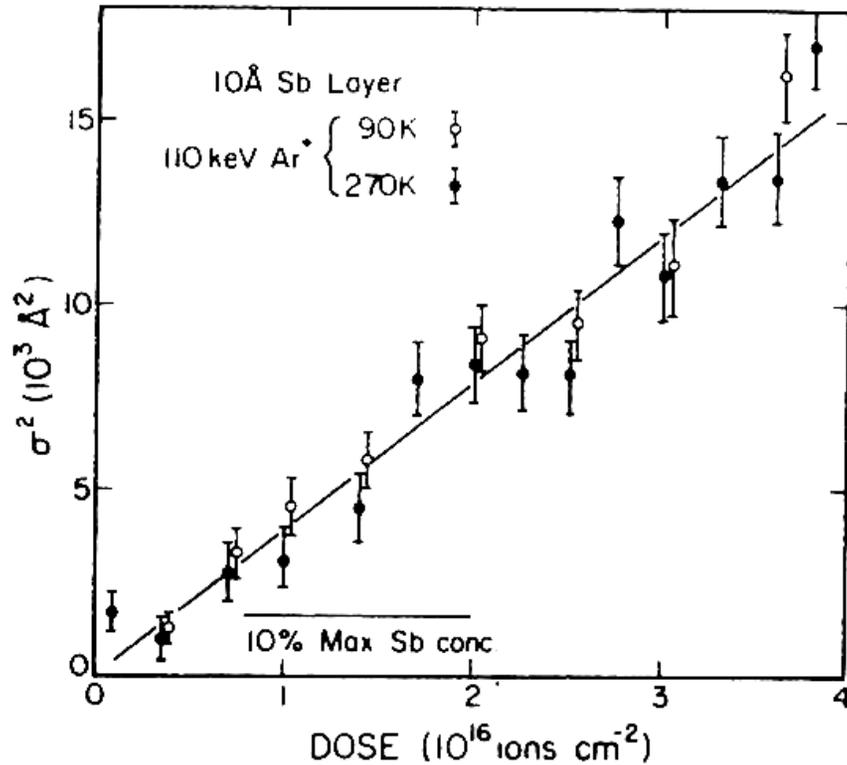
$$\sigma_{\text{total}}^2 = \sigma_{\text{unirrad}}^2 + 4Dt$$



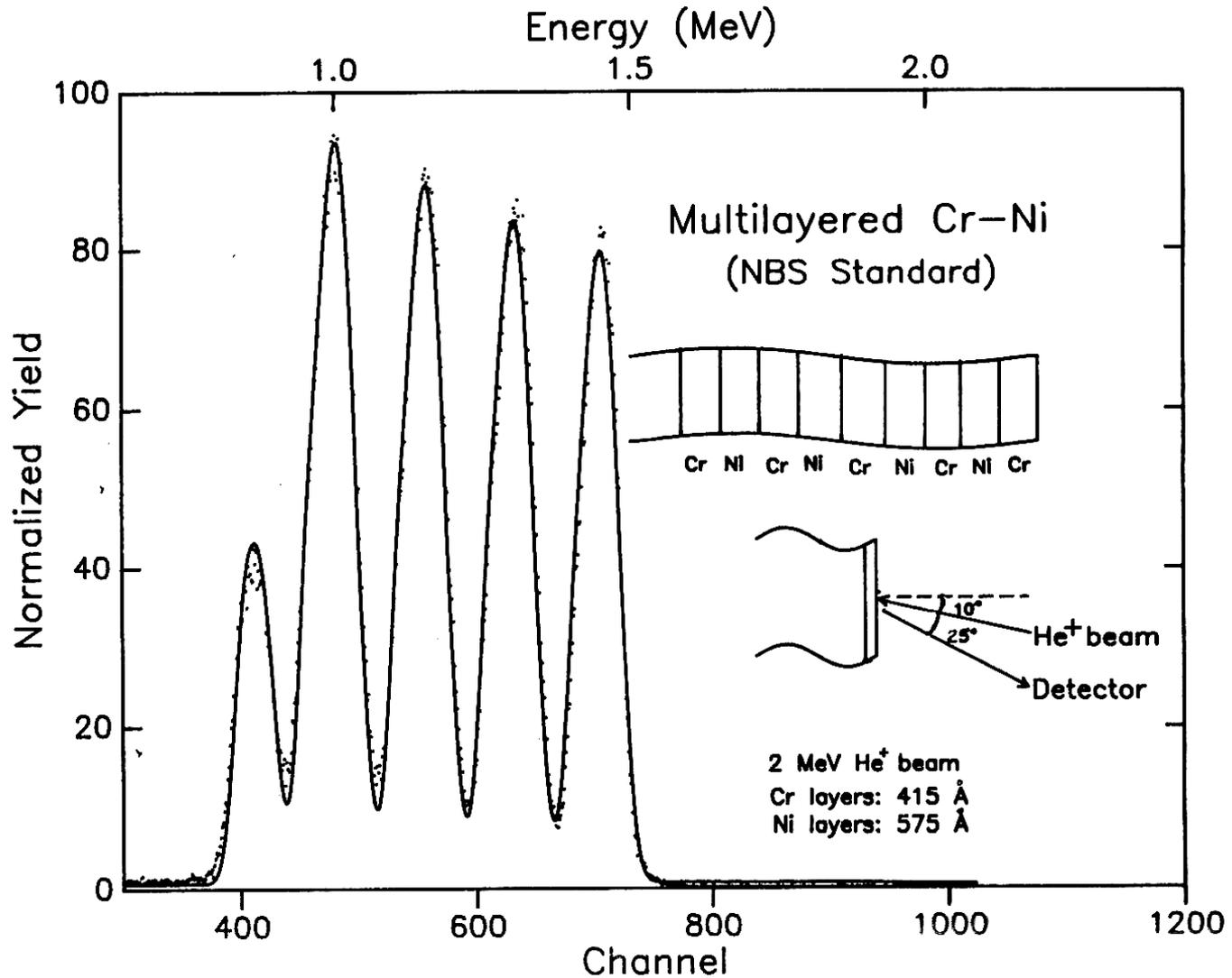
# Broadening of multilayers



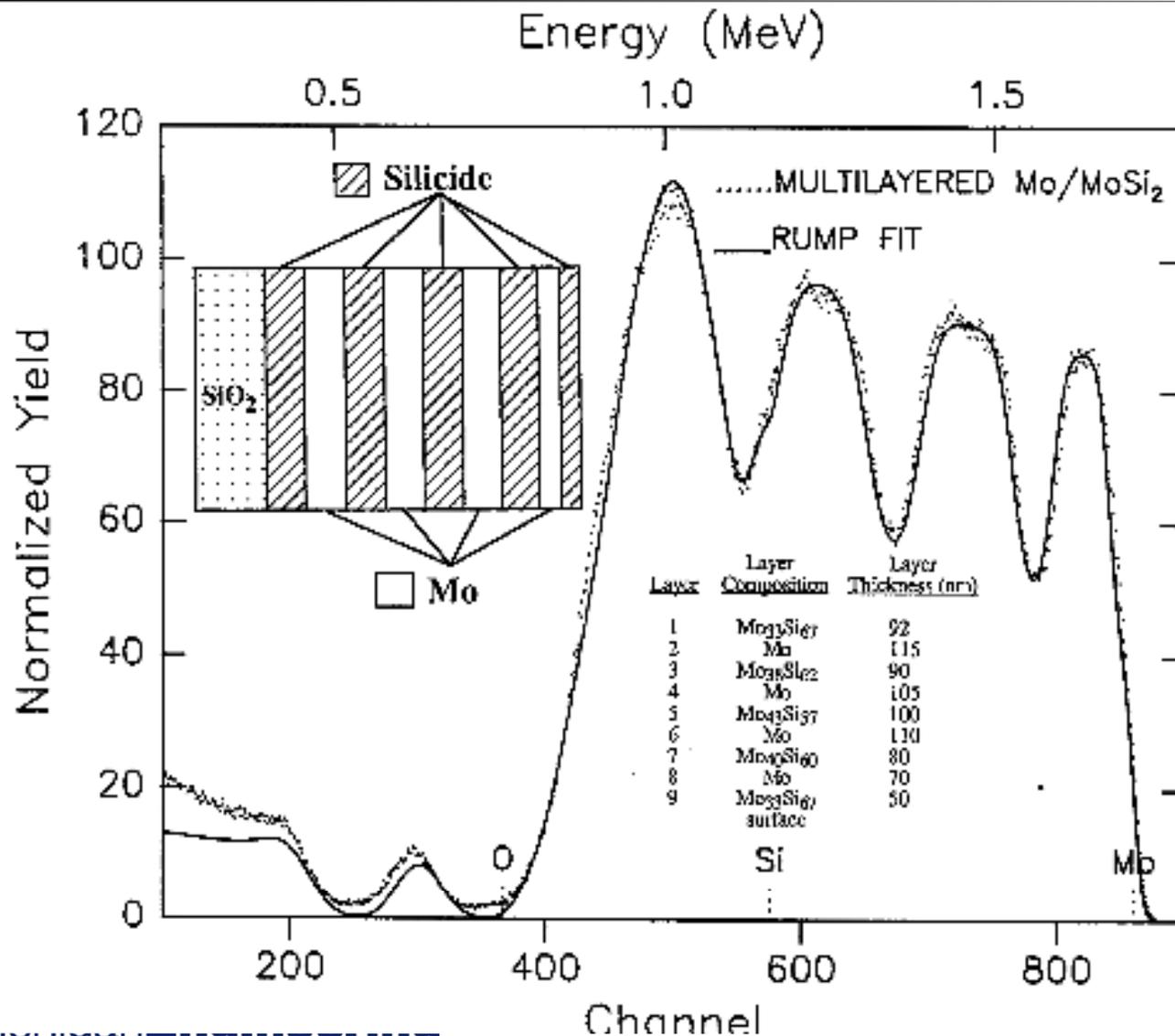
# Dose dependence of interface spreading



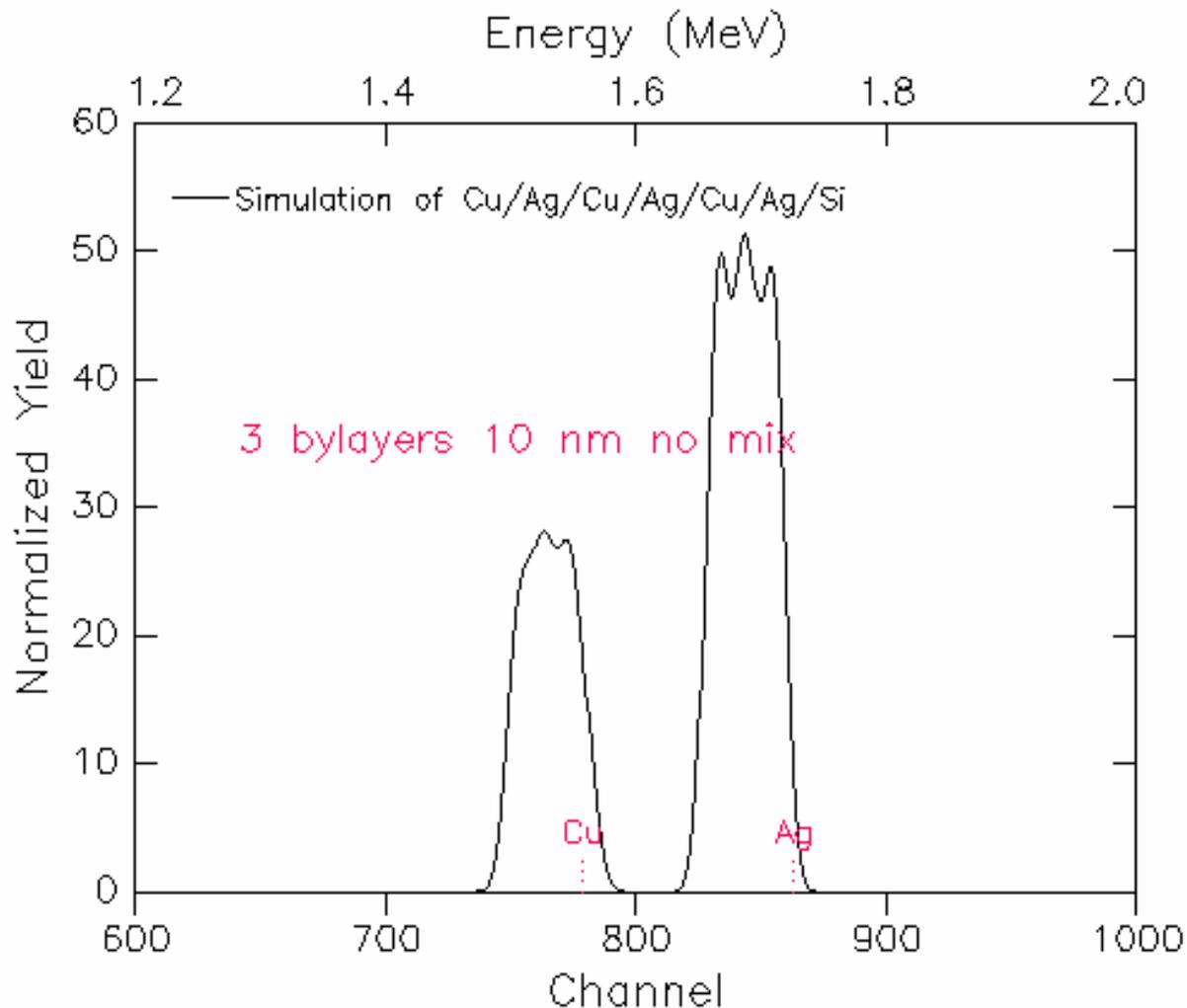
# RBS on a NIST standard



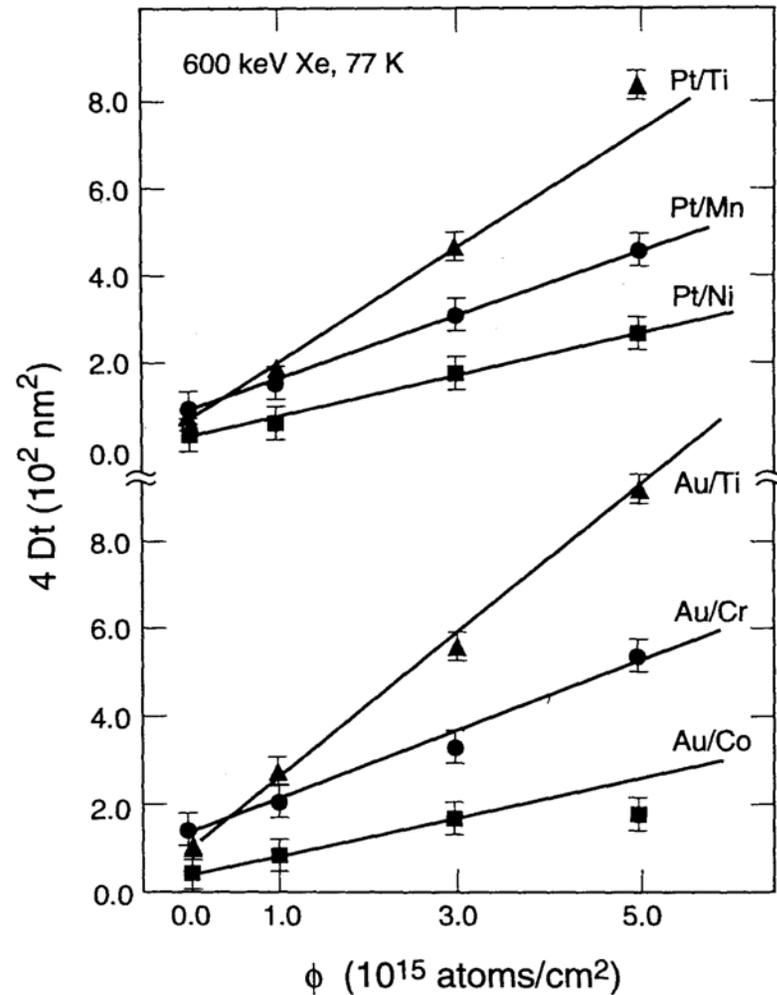
# RBS of Mo/MoSi<sub>2</sub> multilayers



# RBS plot of Ag/Cu multilayer 10 nm layer thickness



# Low temperature ion mixing for several “collisionally similar” bilayer systems



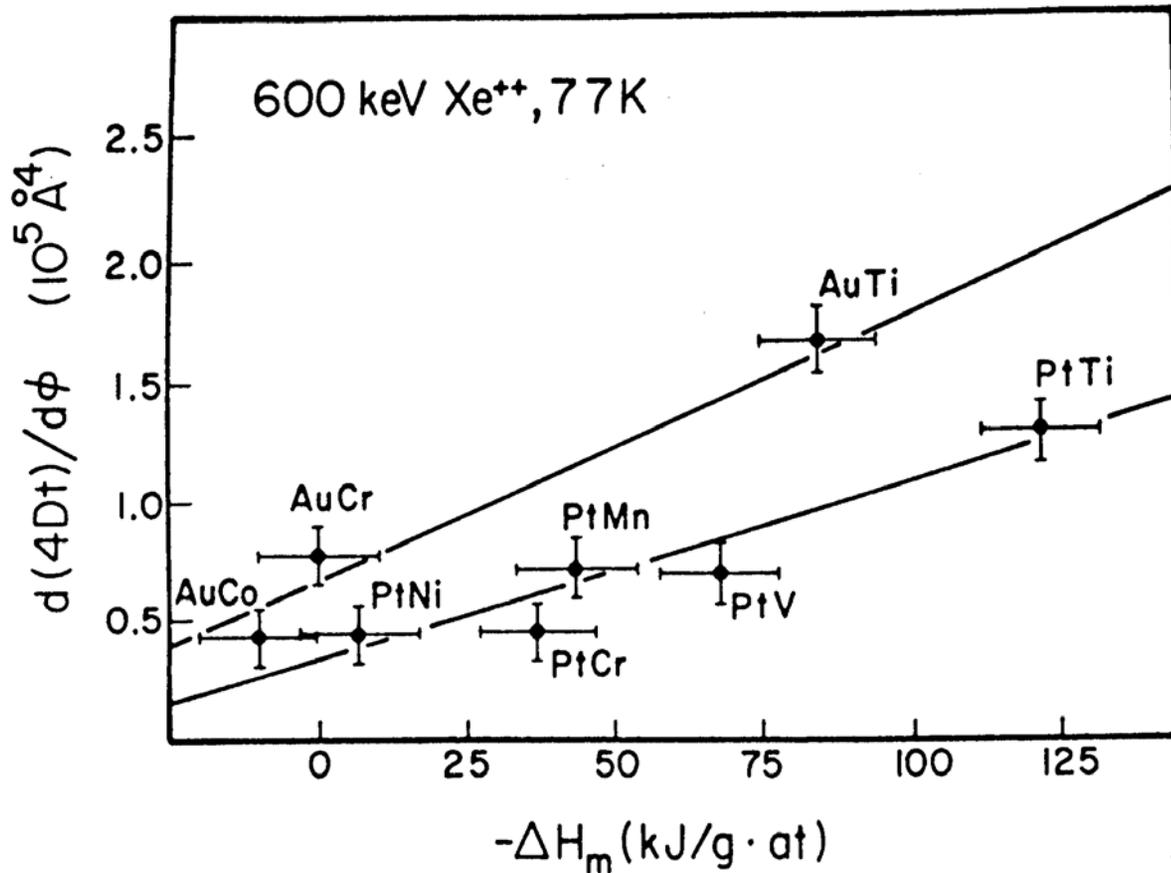
The reason is that fundamentally, diffusion is driven by a chemical potential gradient,  $\nabla \mu(\mathbf{x})$ . For non-ideal solutions, we must relate  $\nabla \mu(\mathbf{x})$  to  $\nabla C(\mathbf{x})$ . This is done by replacing  $D$  with a modified  $D'$  that accounts for the Kirkendall effect and describes diffusional intermixing.

$$D' = [D_A {}^\circ C_B + D_B {}^\circ C_A] [1 + \partial \ln \gamma(C_A) / \partial \ln C_A]$$
$$= D [1 - 2\Delta H_{\text{mix}} / k_B T]$$

This eqn. states that random walk will be *biased* when the potential energy depends on the configuration. So mixing rates depend on the degree of Darkin biasing.

Using using this eqn., the effective temperature at which diffusion occurs can be determined to be  $\sim 1-2$  eV, which also means that this is the particle kinetic energy at which mixing occurs.

# Mixing rates and $\Delta H_{\text{mix}}$ for several metallic bilayer systems irradiated with 600 keV Xe at 77K



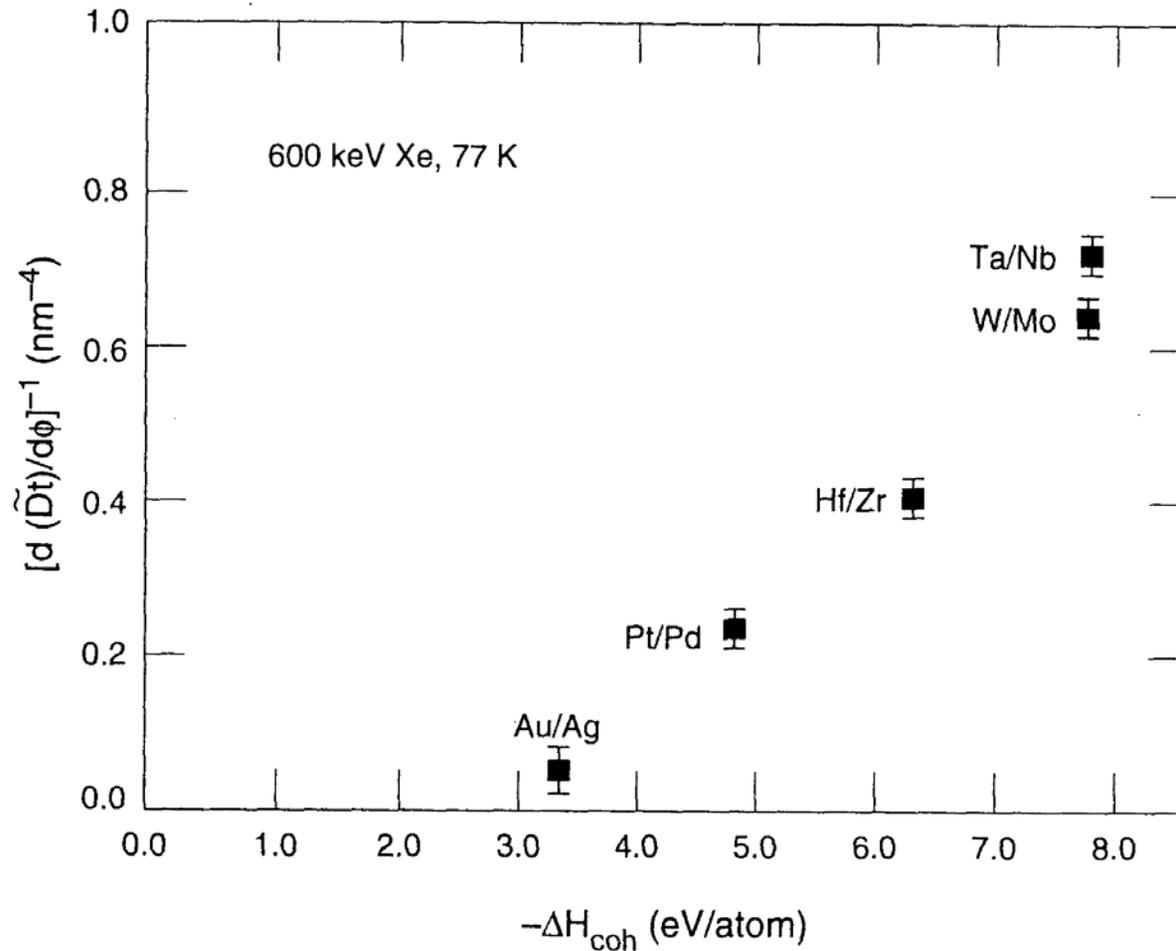
Since mixing depends on the thermodynamic properties, it should depend on  $\Delta H_{\text{COH}}$ , a measure of how tightly bound atoms are in a solid.

The atom jump rate in a thermal spike can be determined from the cascade energy density and used to derive the mixing rate:

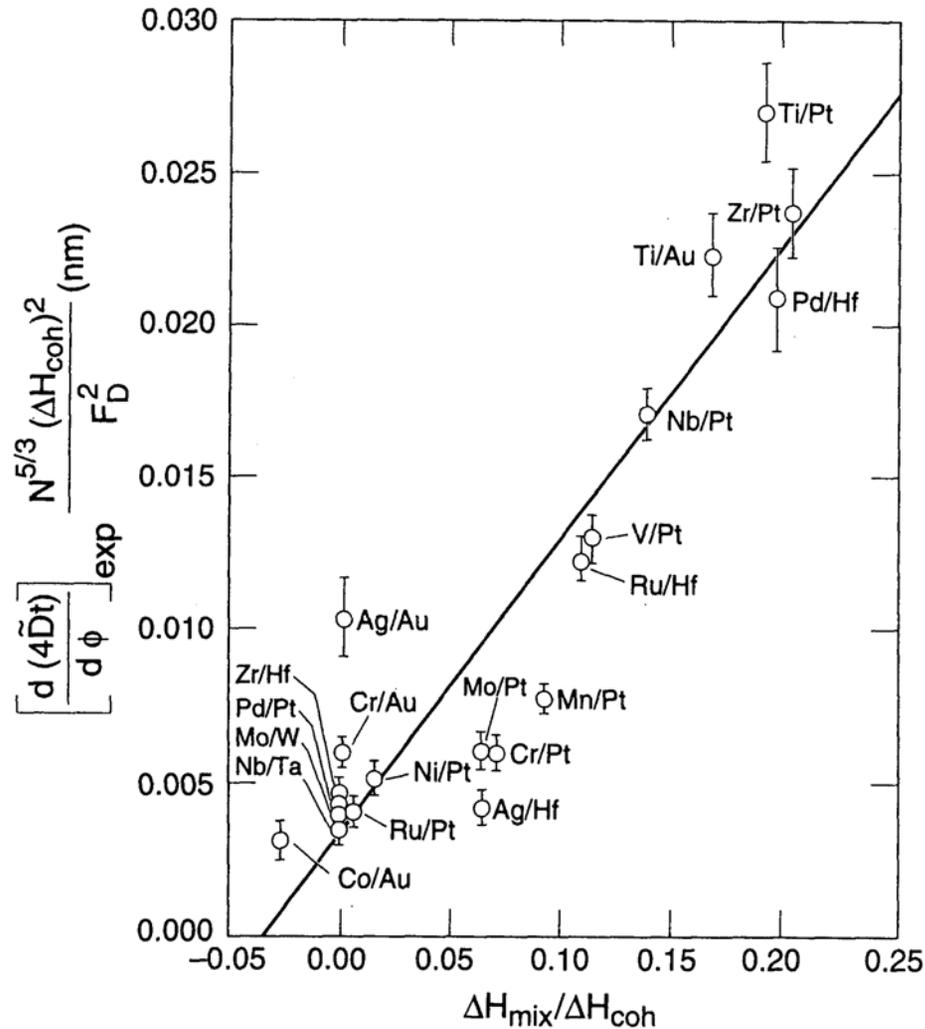
$$\frac{d(4Dt)}{d\phi} = \frac{K_1 \epsilon^2}{N^{5/3} (\Delta H_{\text{COH}})^2} (1 + K_2 \Delta H_m / \Delta H_{\text{COH}})$$



# Influence of the cohesive energy on ion mixing



# Experimental mixing data showing a linear relationship between the mixing rate and the ratio $\Delta H_{\text{mix}}/\Delta H_{\text{coh}}$



## Experimental and calculated ion mixing data for several systems

System (A-B)	$-\Delta H_{\text{mix}}$ (kJ/gram- atom)	$-\Delta H_{\text{coh}}$ (eV/atom)	$F_D$ ( $10^3$ eV/nm)	$\bar{N}$ ( $\text{nm}^{-3}$ )	$(4\bar{D}t/\phi)_{\text{exp}}$ ( $\text{nm}^4$ )	$(4\bar{D}t/\phi)_{\text{calc}}$ ( $\text{nm}^4$ )
Pt/Ti	122	6.60	445	61.4	12.8	10.7
Pt/V	68	6.27	491	69.2	6.8	7.8
Pt/Mn	43	4.82	531	74.0	7.3	11.9
Pt/Cr	36	5.34	530	74.7	4.5	7.8
Pt/Ni	7	5.21	582	78.8	4.5	4.4
Au/Ti	84	5.20	414	57.8	16.3	14.8
Au/Cr	0	3.96	498	71.2	7.8	4.8
Au/Co	-11	3.99	539	74.3	4.5	1.2
Pt/Pd	0	4.87	554	67.1	4.5	4.3
Hf/Zr	0	6.34	355	44.0	2.6	2.2
W/Mo	0	7.86	519	63.6	1.6	1.6
Ta/Nb	0	7.84	445	55.6	1.4	1.5
Au/Ag	0	3.38	480	58.8	23.7	8.4

WL Johnson, et al, Nucl. Instr. Meth B7/8 (1985) 657.



## Effect of Temperature

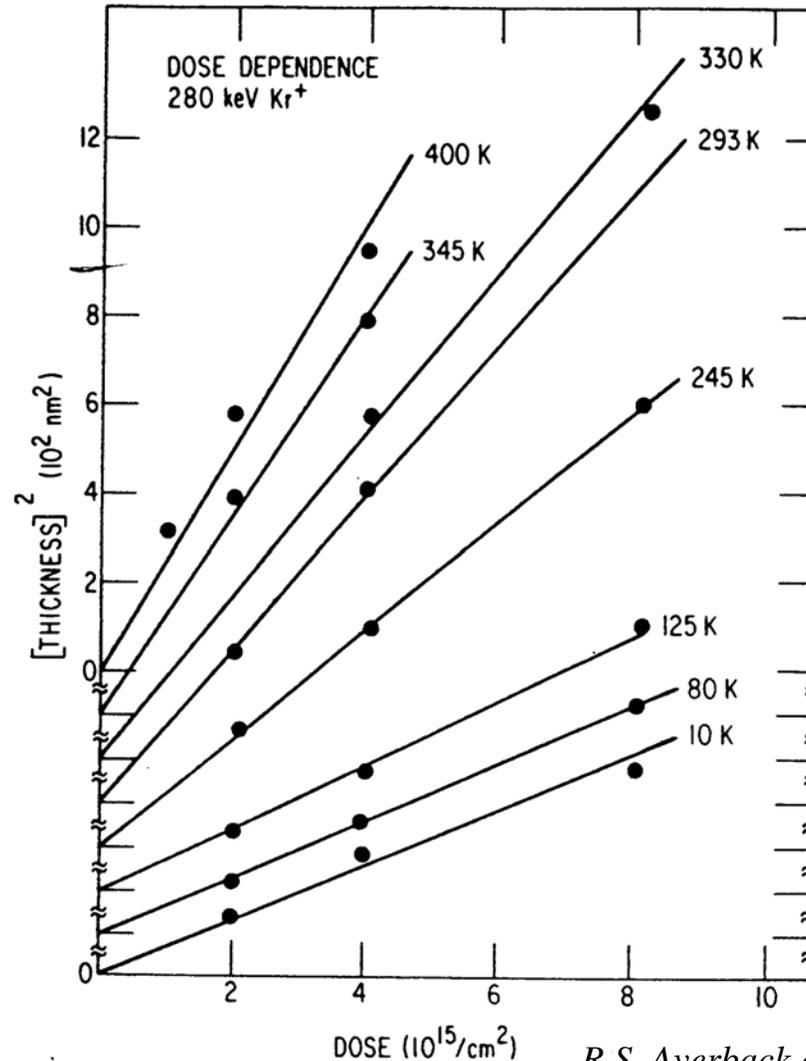
When the temperature increases, we begin to see effects due to radiation-enhanced diffusion and radiation-induced segregation.

Systems with negative heats of mixing will likely mix easily and form intermetallic phases.

Systems with positive heats of mixing will likely resist mixing and will tend to maintain the multilayer structure. Ballistic intermixing will be opposed by thermodynamically-driven demixing and the resulting composition profiles will be a result of these opposing processes.



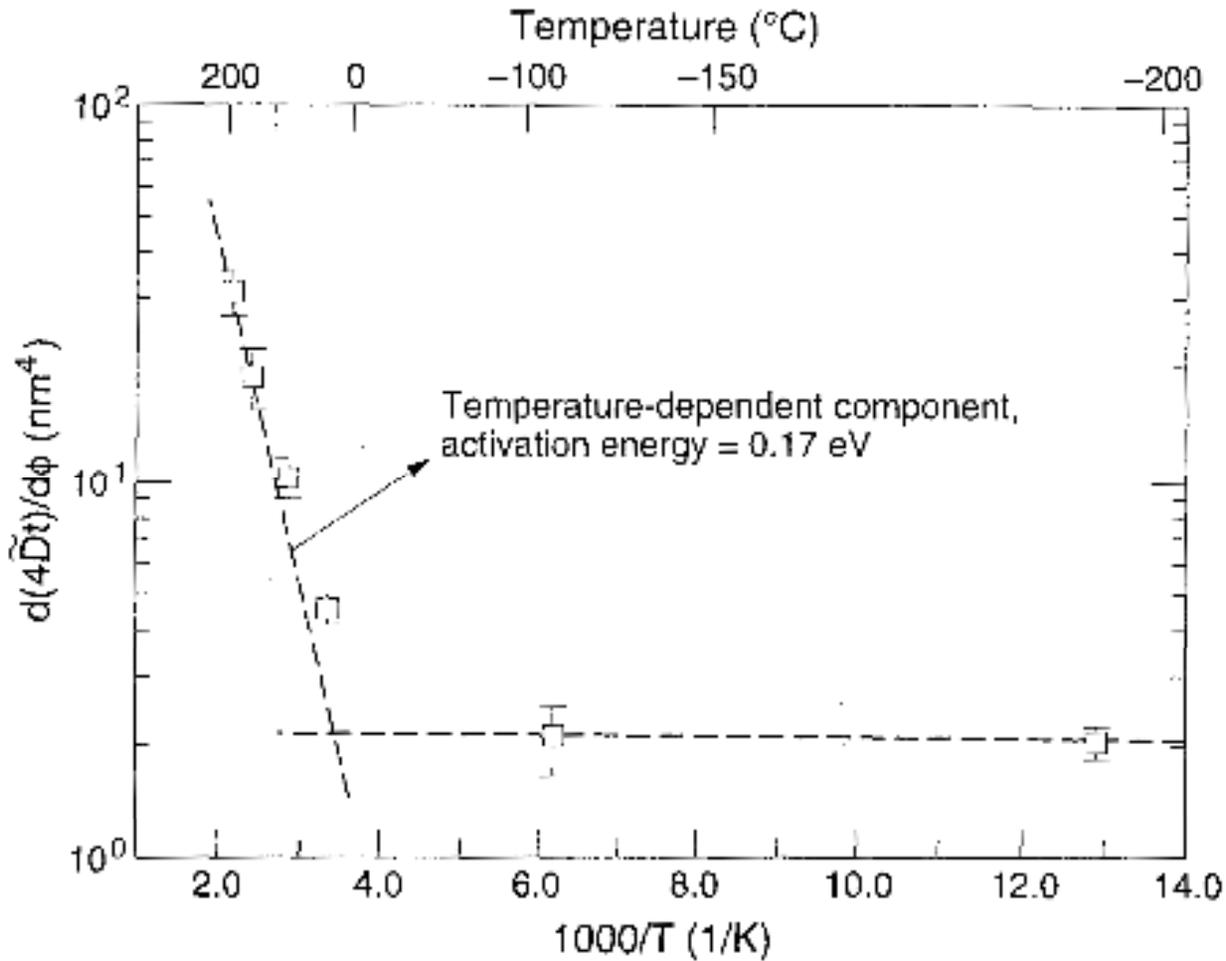
# Dose dependence of ion beam mixing for Ni-Si for 280 keV $\text{Kr}^+$ irradiation at several temperatures



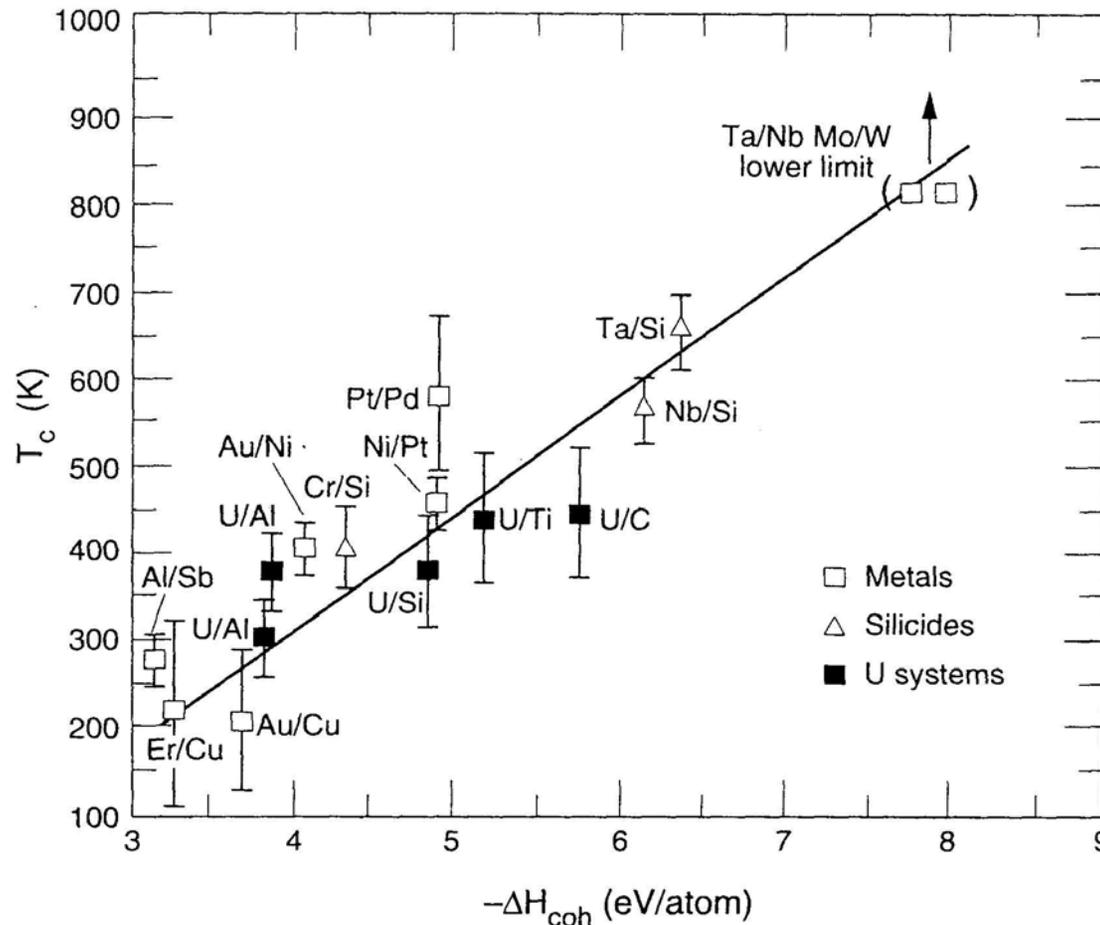
R.S. Averback et al. *J. Appl. Phys.* 53 (1982) 1342



# Influence of temperature on mixing in Al/Mo



# Correlation between ballistic mixing (T-independent) and temperature-dependent mixing transition, $T_c$ and the average cohesive energy of the bilayer alloy

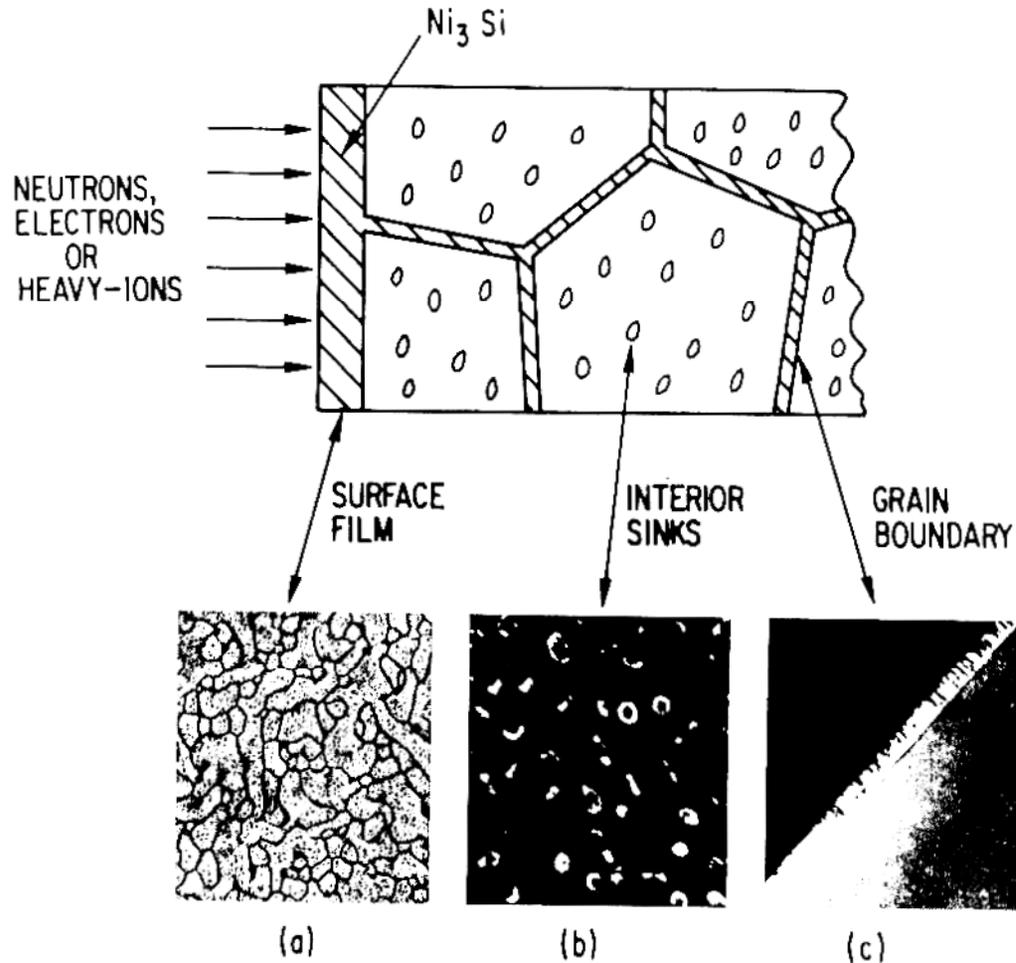


# Effect of irradiating particle mass and energy

- Light, high energy ions produce large cascade volume but with widely separated spikes and minimal overlap.
- Heavy ions produce a smaller total cascade volume in few spikes that are closely spaced or overlapping.
- Overall, the overlap of heavy ion irradiation results in a higher mixing efficiency for heavy ions.

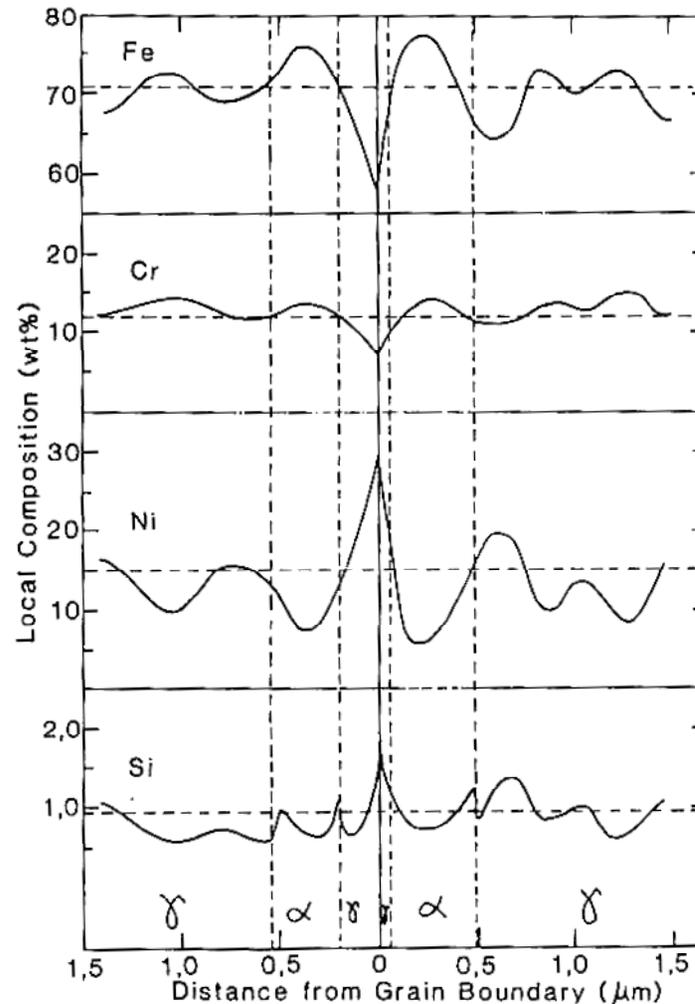


# Formation of $\gamma'$ -Ni<sub>3</sub>Si on defect sinks in a solid-solution Ni-Si alloy due to radiation induced segregation



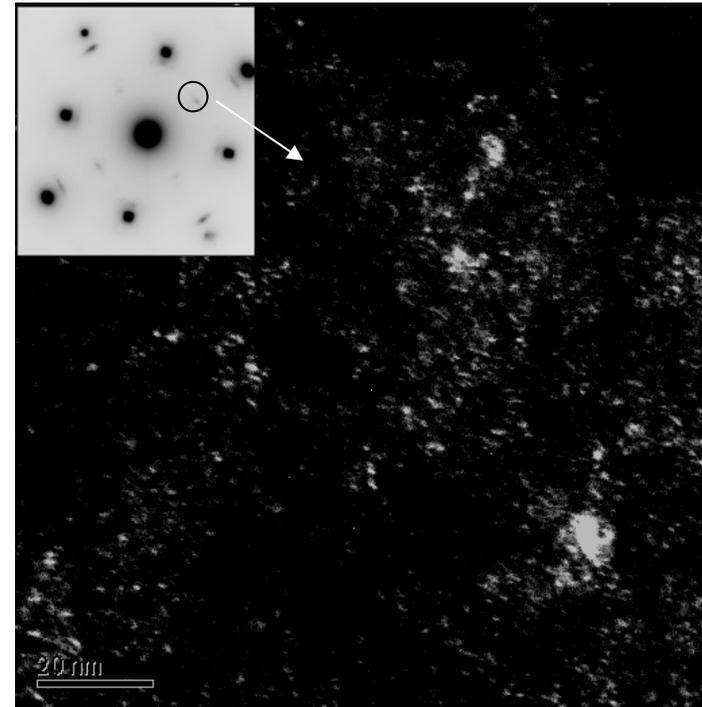
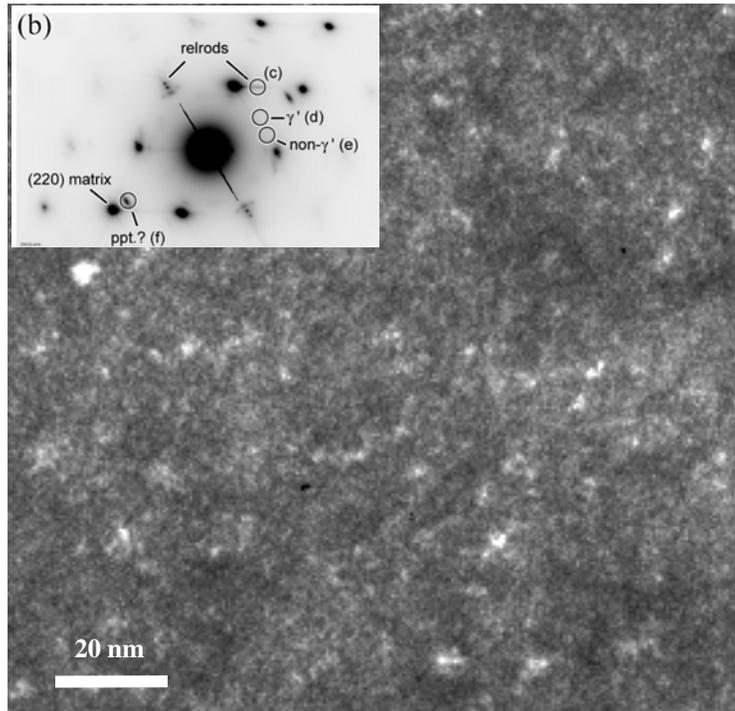
*L. E. Rehn, et al., Metastable Materials Formation by Ion Irradiation, Elsevier (1982) 17.*

# Variation in composition near a grain boundary in Fe-12Cr-15Ni-0.95Si after irradiation to 23.6 dpa at 645°C



*T. M. Williams, et al., Radiation Induced Sensitization of Stainless Steels, Berkeley Nuclear Labs, (1987) 116.*

# Comparison of $\gamma'$ in proton- and neutron-irradiated SS



**Tihange baffle bolt:**  
neutron-irradiated to  $\sim 7$  dpa  
at  $299^\circ\text{C}^*$ .

**heat H** proton-irradiated to  
5.5 dpa at  $360^\circ\text{C}$ .

*• ATEM Characterization of Stress-Corrosion Cracks in LWR-Irradiated Austenitic Stainless Steel Core Components, PNNL EPRI Report, 11/2001.*

*• Image resized for equivalent scale.*



# Comparison of precipitation in proton- and neutron-irradiated SS

**Tihange baffle bolt:** neutrons  
299°C to ~7 dpa\*

**heat H:** protons  
360°C to 5.5 dpa

Size

few nm

2.2 nm  
(0.2 % vol.fraction)

Location

In matrix of grains,  
Not observed at GB

In matrix of grains,  
None found at GB

Composition

Ni, Si enriched  
Cr depleted

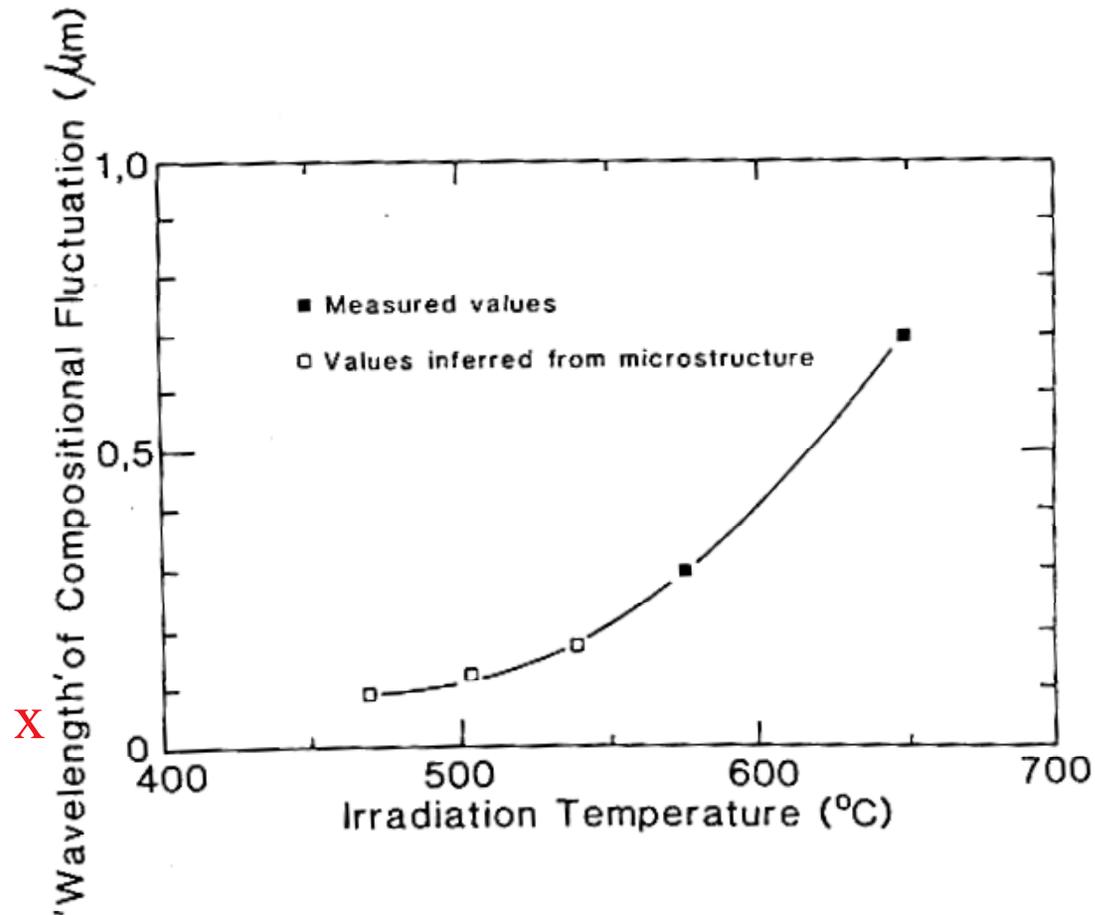
Significant Ni, Si enrichment  
Cr depletion

**Extra spot is not gamma prime**

\* *ATEM Characterization of Stress-Corrosion Cracks in LWR-Irradiated Austenitic Stainless Steel Core Components, PNNL EPRI Report, 11/2001.*



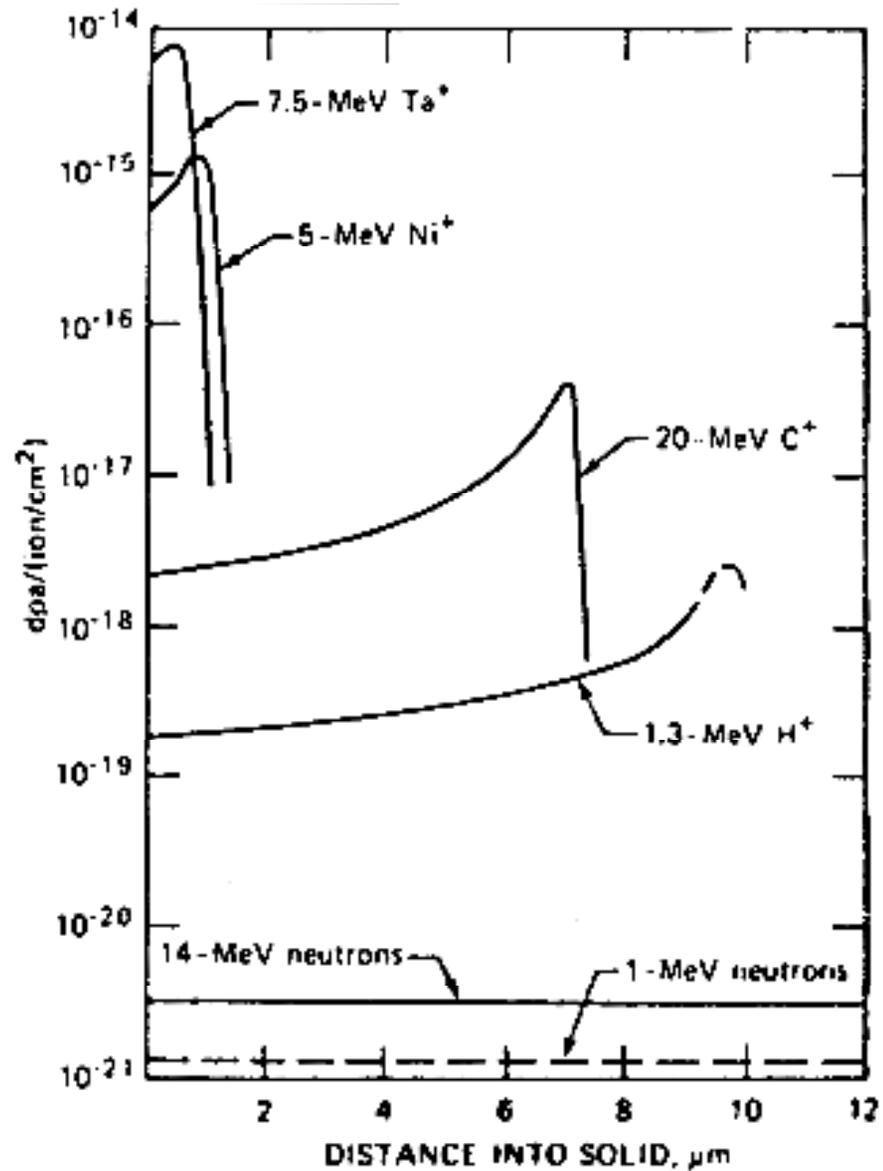
# Wavelength of compositional fluctuation in neutron-irradiated SS



# Irradiation of Multilayer Structures

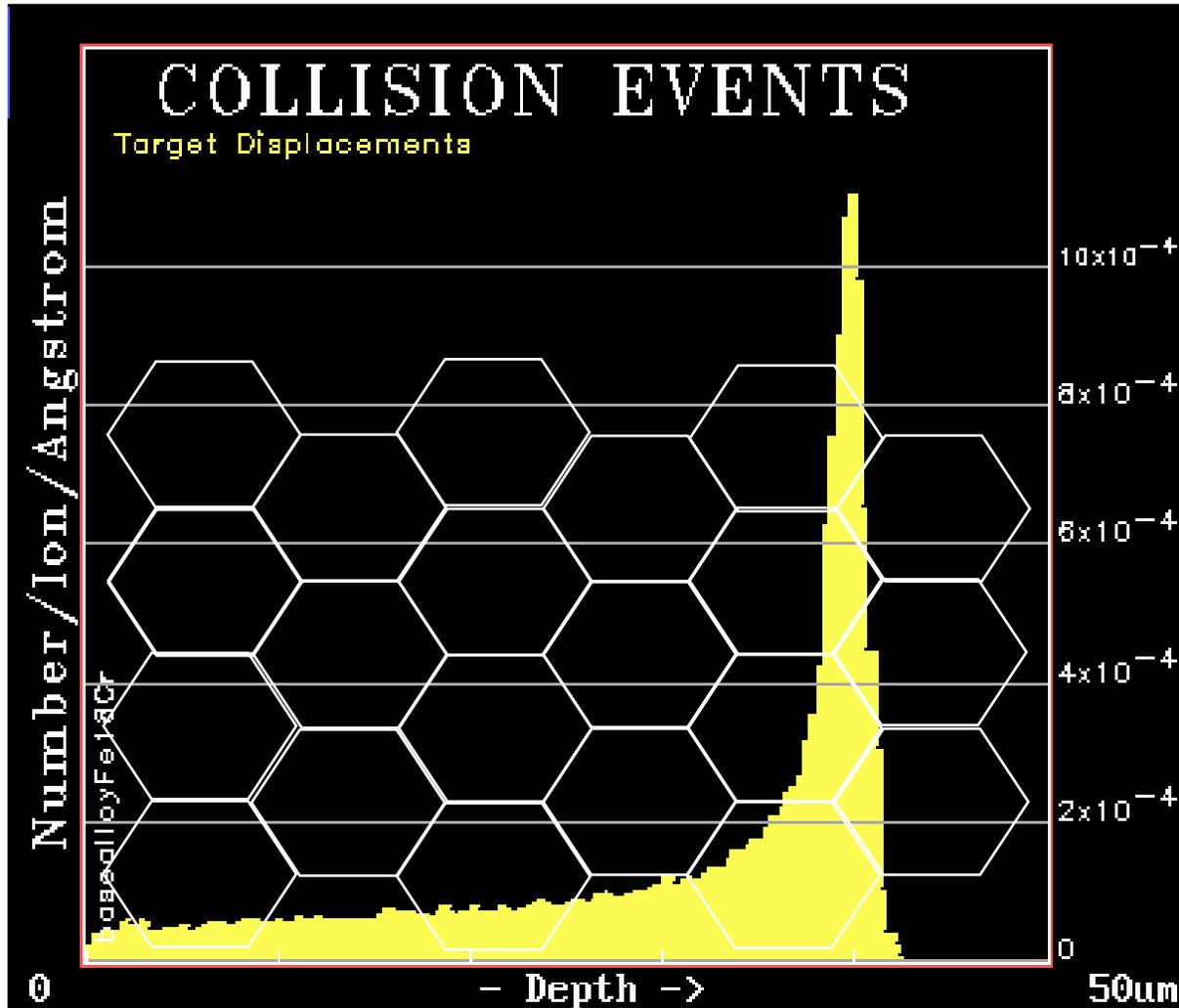


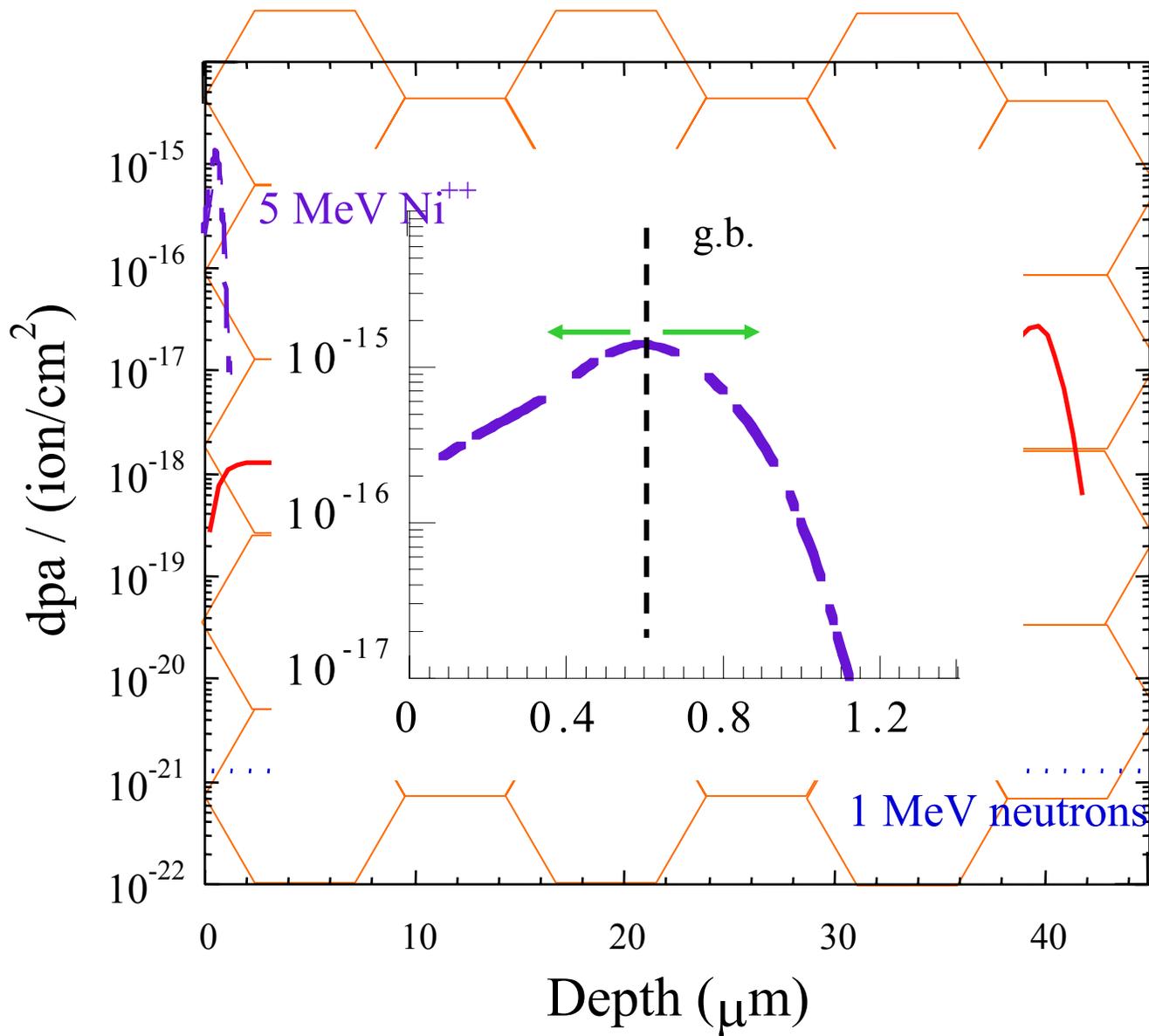
# Flux-normalized displacement rate as a function of depth for various particles



*G.L. Kulcinski et al, Radiation-Induced Voids in Metals, 1972*

# 3.2 MeV proton damage profile





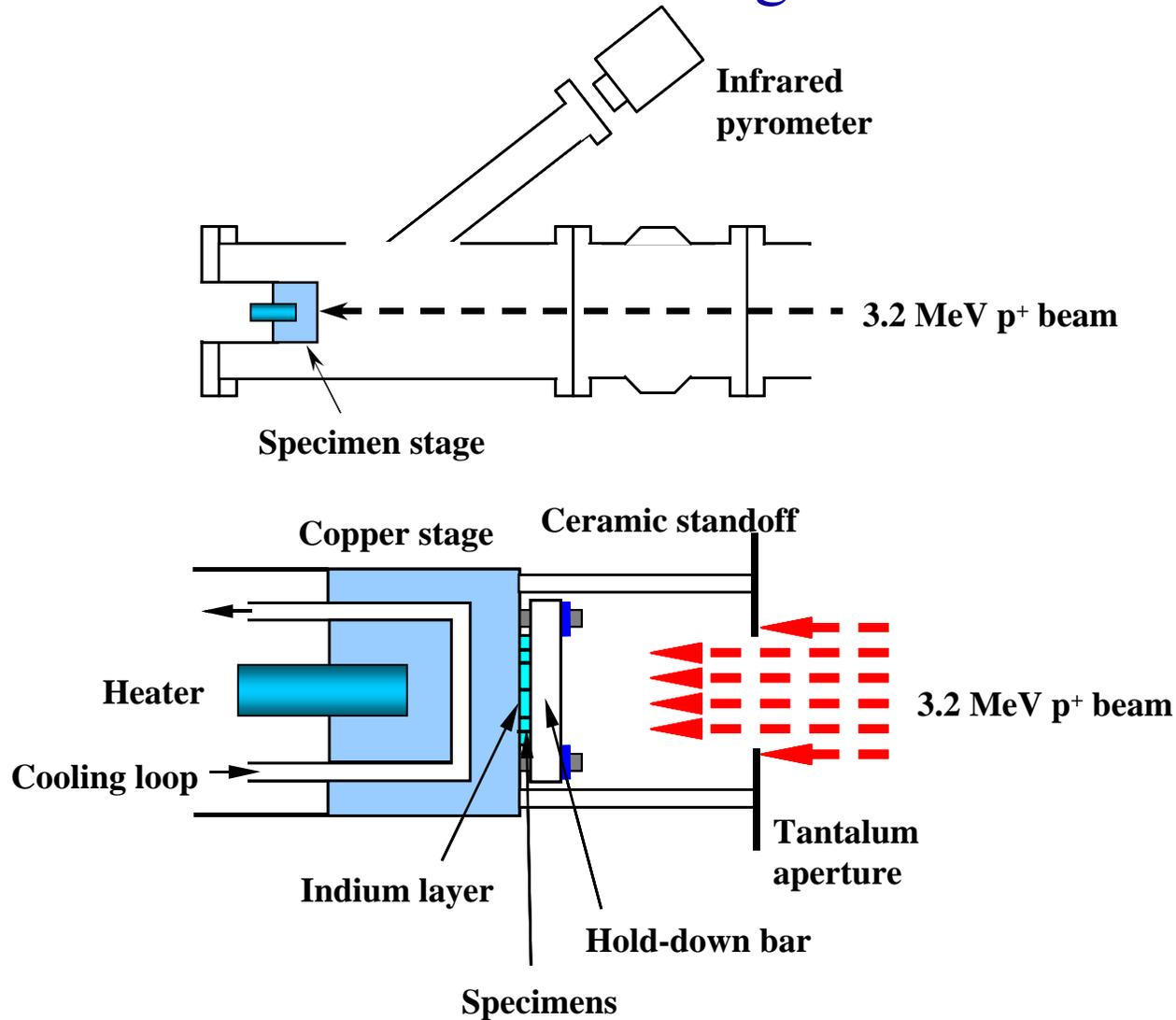
QuickTime™ and a  
Photo CD Decompressor  
are needed to use this picture

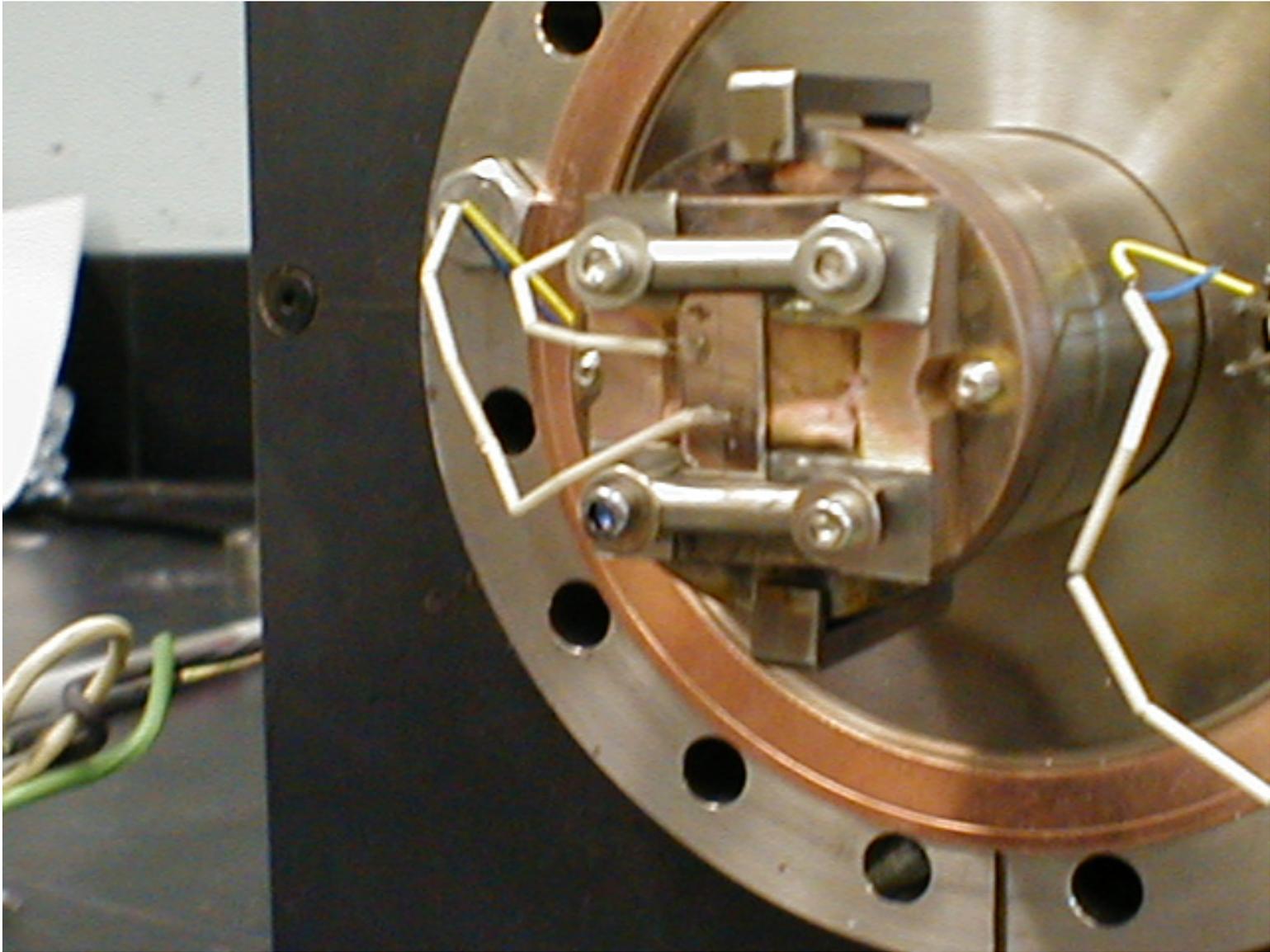


Michigan**Engineering**

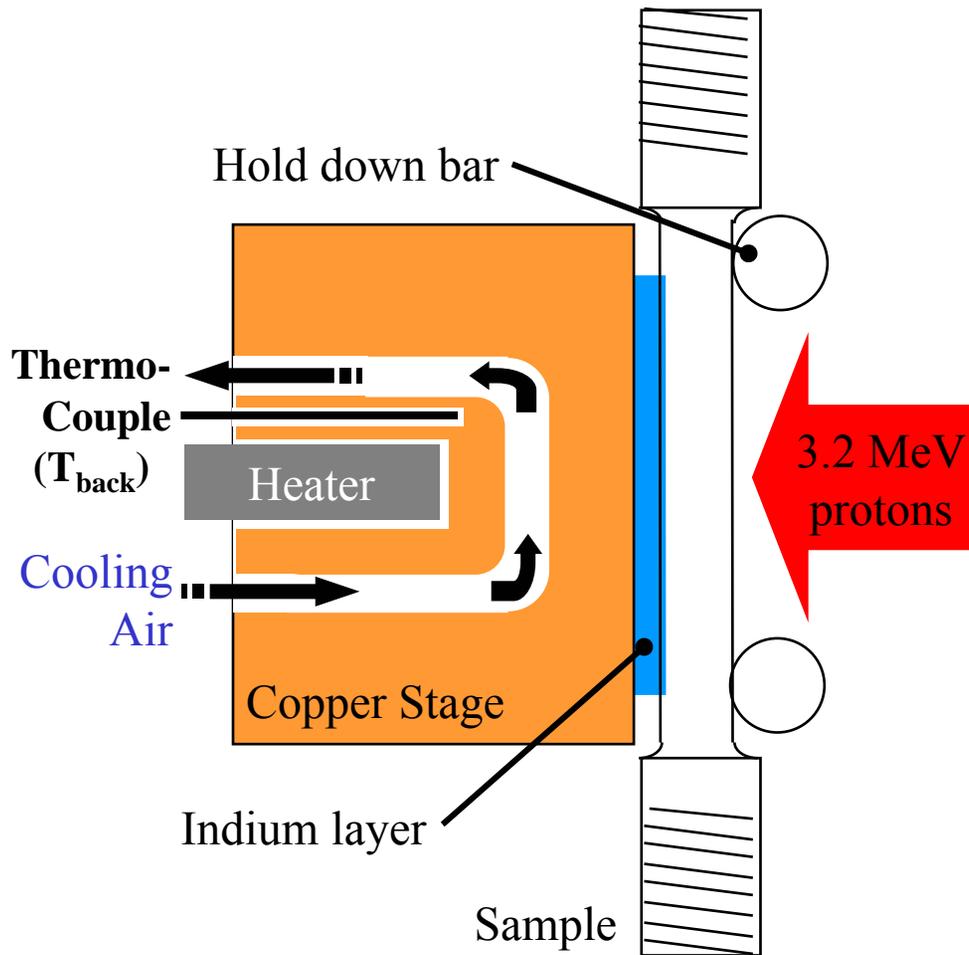
---

# Proton irradiation in the Michigan Ion Beam Laboratory





# Temperature control during proton irradiation



In general,

$$q'' = -k \frac{dT}{dx}$$

or,

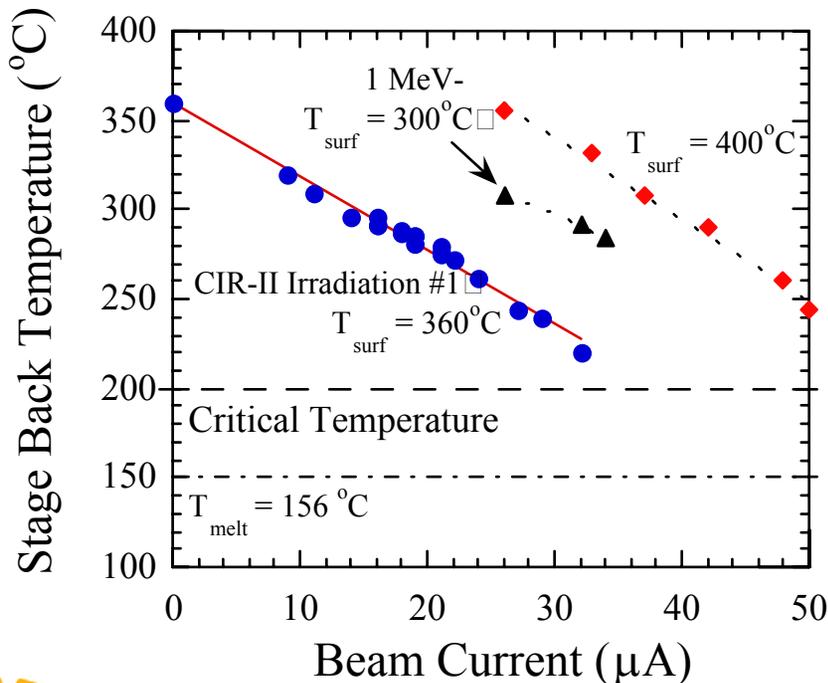
$$q'' = k \frac{(T_{surf} - T_{back})}{\Delta x}$$
$$= U_{eff} (T_{surf} - T_{back})$$

where,

$$\frac{1}{U_{eff}} = \frac{L_{Cu}}{k_{Cu}} + \frac{L_{In}}{k_{In}} + \frac{L_{SS}}{k_{SS}} + \frac{1}{k_{gap}}$$

# Key to Temperature Control

- $T_{\text{back}}$  is carefully monitored as beam current is steadily increased until  $T_{\text{back}}$  approaches  $200^{\circ}\text{C}$ .
- Higher beam currents are possible for higher temperature irradiations ( $T = 400^{\circ}\text{C}$ ).



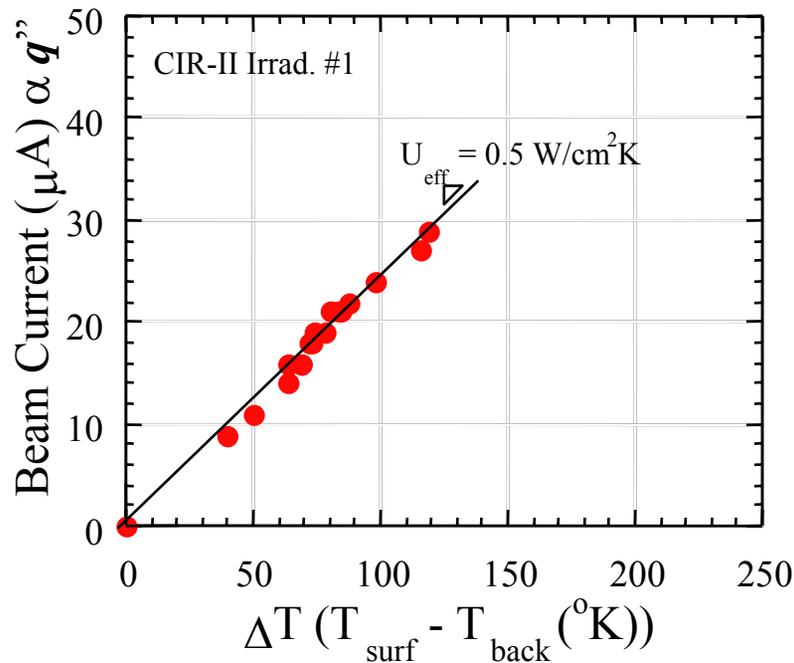
- Critical temperature can be reduced for lower irradiation temperatures ( $T = 360^{\circ}\text{C}$  or  $300^{\circ}\text{C}$ ) by alloying In and Ga to reduce the melting point of the interface material.



# Determination of heat transfer coefficient

- Conductance can be determined from beam current (heat flux) and  $T_{\text{back}}$ .

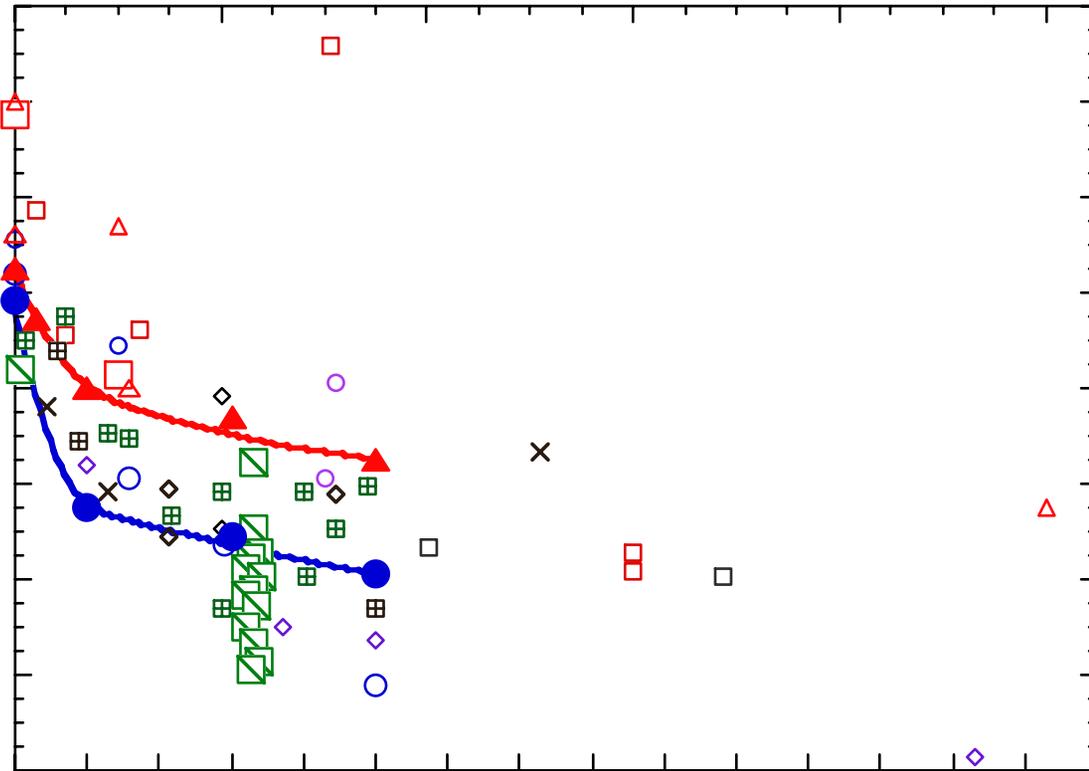
$$\frac{1}{U_{\text{eff}}} = \frac{L_{\text{Cu}}}{k_{\text{Cu}}} + \frac{L_{\text{In}}}{k_{\text{In}}} + \frac{L_{\text{SS}}}{k_{\text{SS}}} + \frac{1}{k_{\text{gap}}}$$



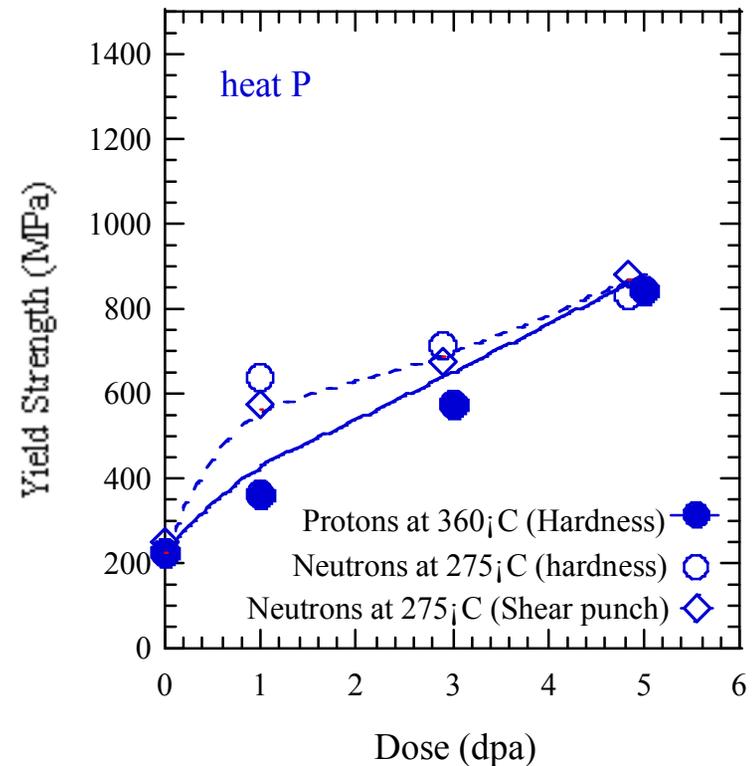
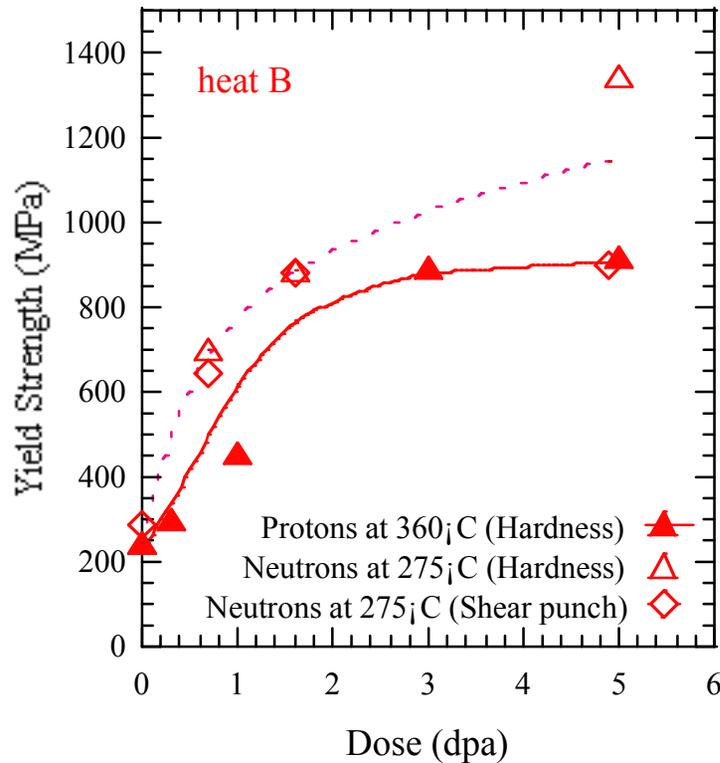
- Experimental conductance is  $0.5 \text{ W/cm}^2\text{K}$ .
- Theoretical conductance for existing stage is  $U_{\text{eff}} = 0.69 \text{ W/cm}^2\text{K}$ , with no gap resistance (i.e., perfect interface)



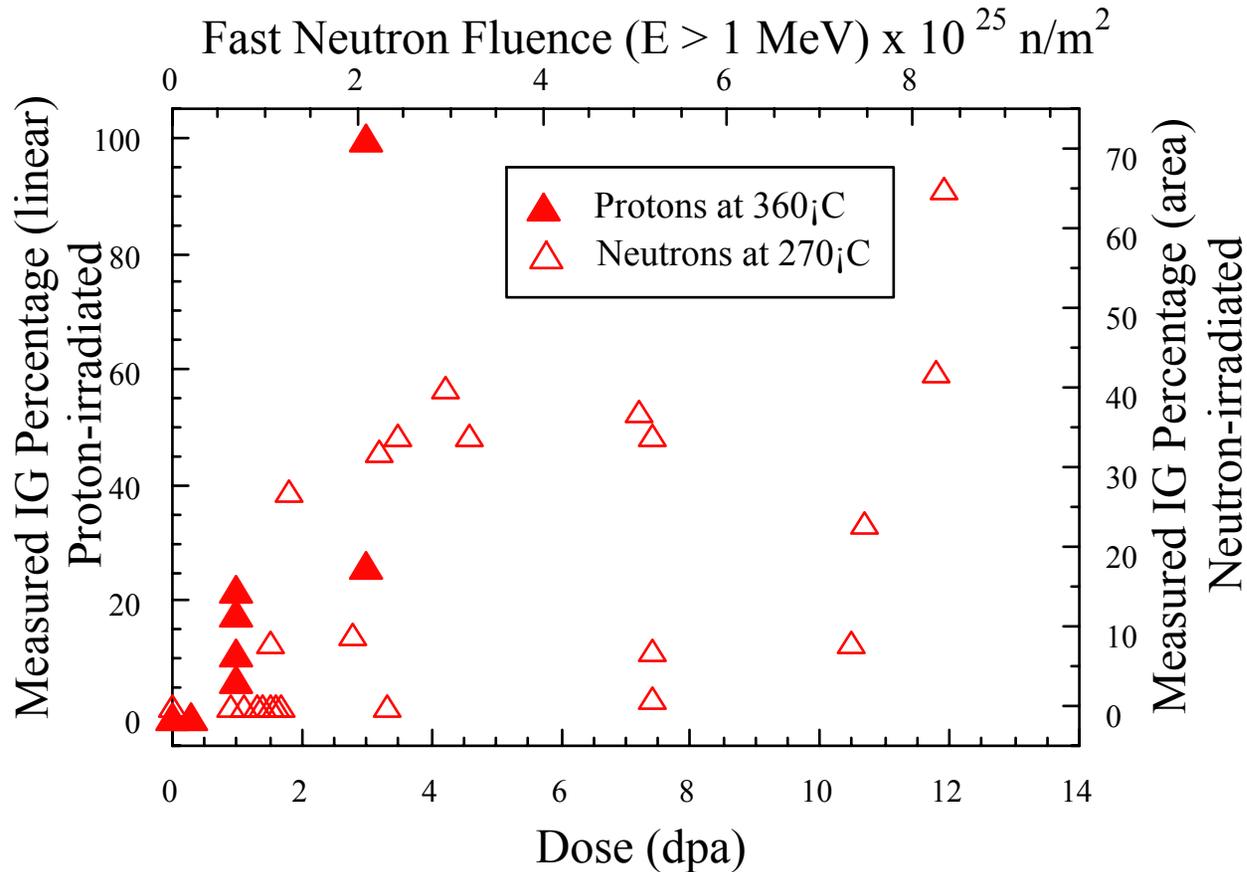
# Grain boundary Cr depletion in proton and neutron irradiated stainless steels



# Dose dependence of yield strength as determined from hardness (proton- and neutron-irradiated) and shear punch (neutron-irradiated) measurements



# Proton-neutron comparison: IGSCC susceptibility in NWC of 304 SS



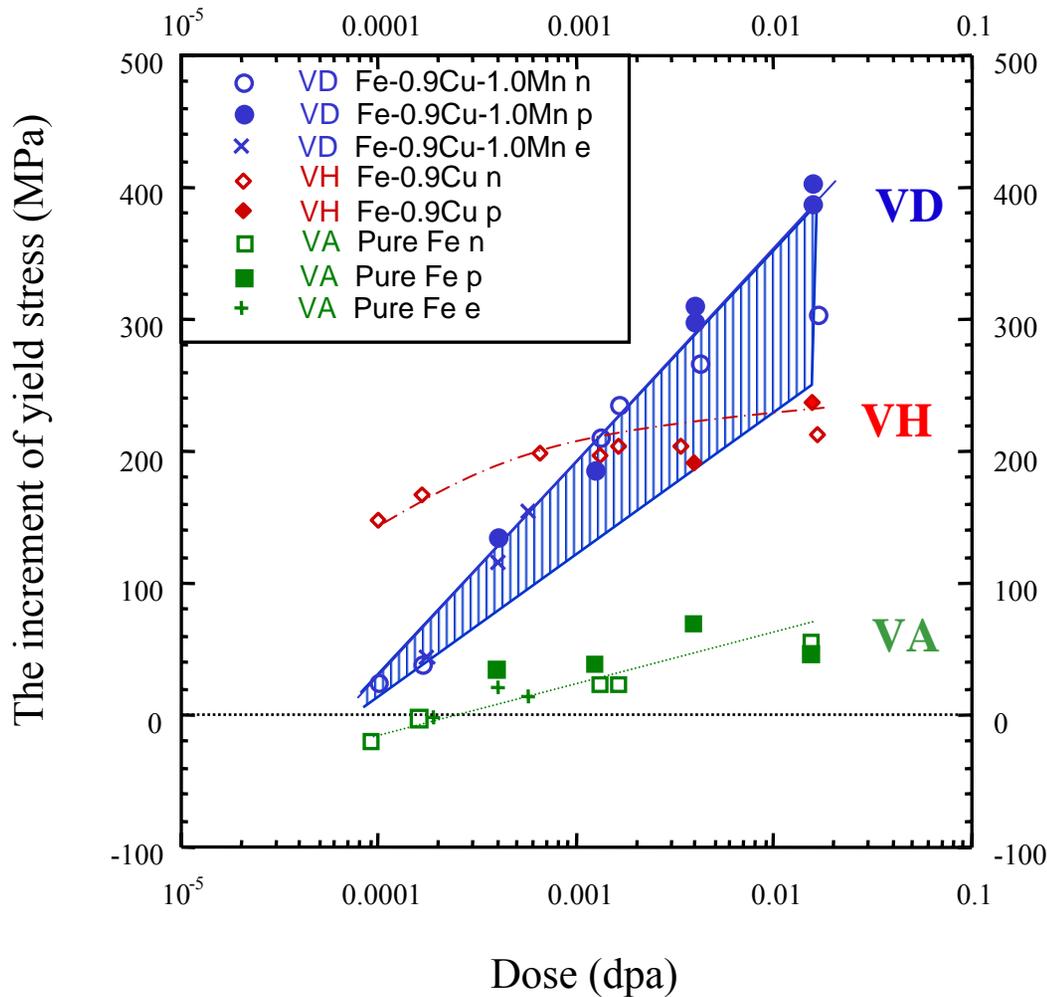
*%IG area measurements made by ABB (taken from CIR database)*

*Proton-irradiated samples strained to failure.*

*Neutron-irradiated samples strained for 168 hours.*



# Yield stress increase vs. dose for model RPV steels



T=300°C

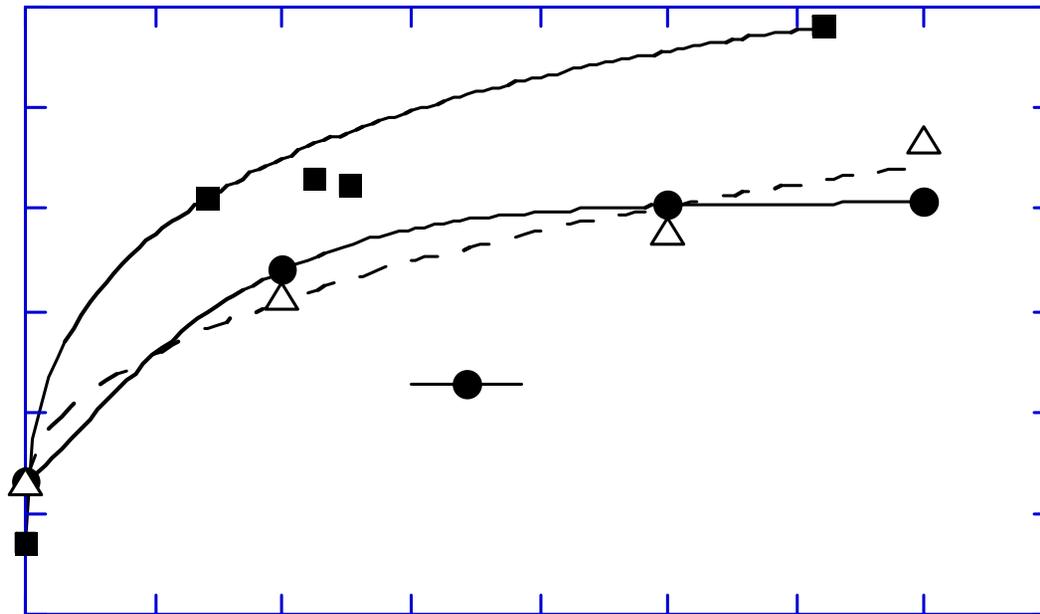
p:  $3 \times 10^{-7}$  dpa/s

e:  $7 \times 10^{-9}$  dpa/s

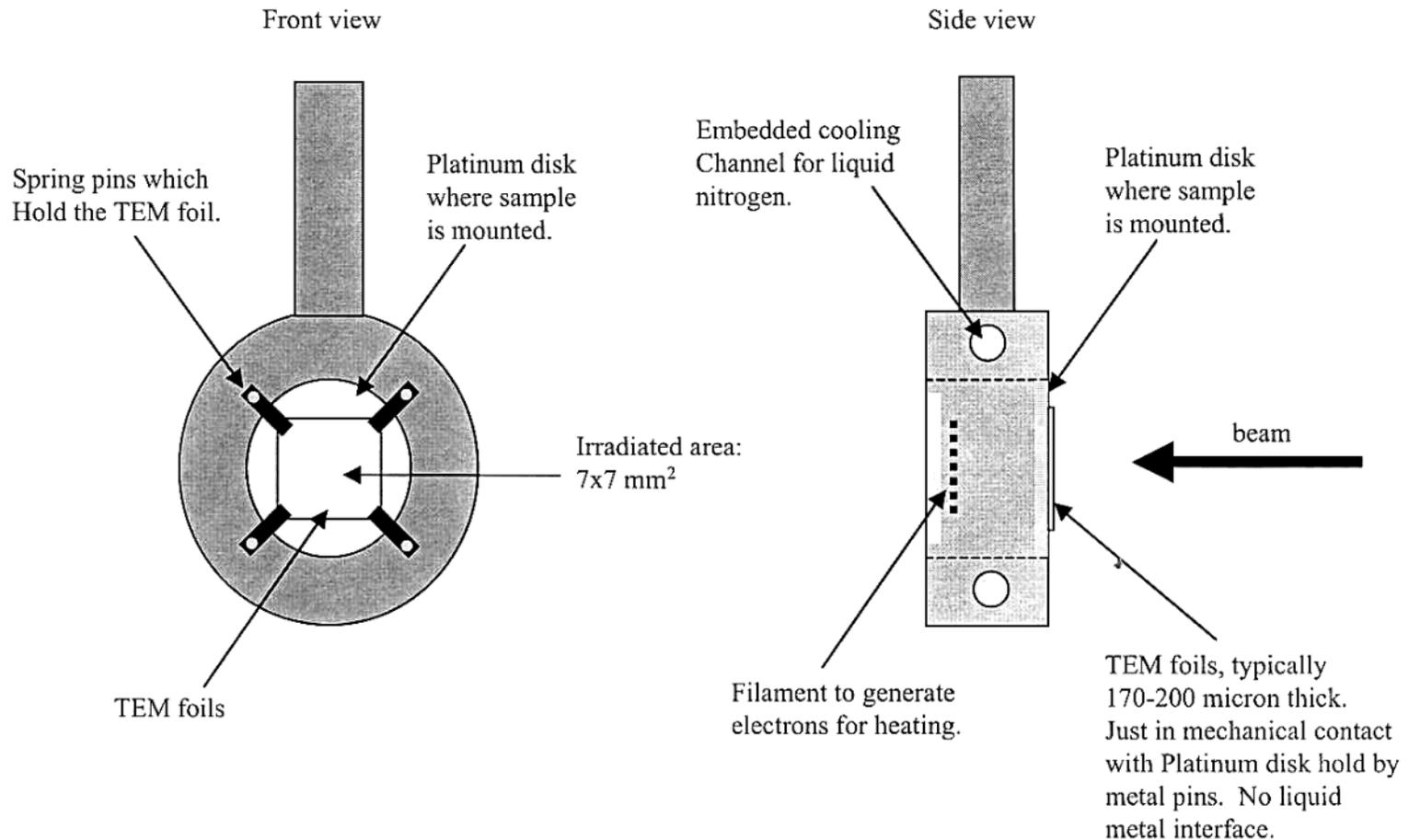
n:  $3 \times 10^{-10}$  dpa/s



# Radiation hardening of proton and neutron irradiated Zircaloy alloys



# Schematic of PNNL ion irradiation stage ( J. Gan, 7-23-2002)

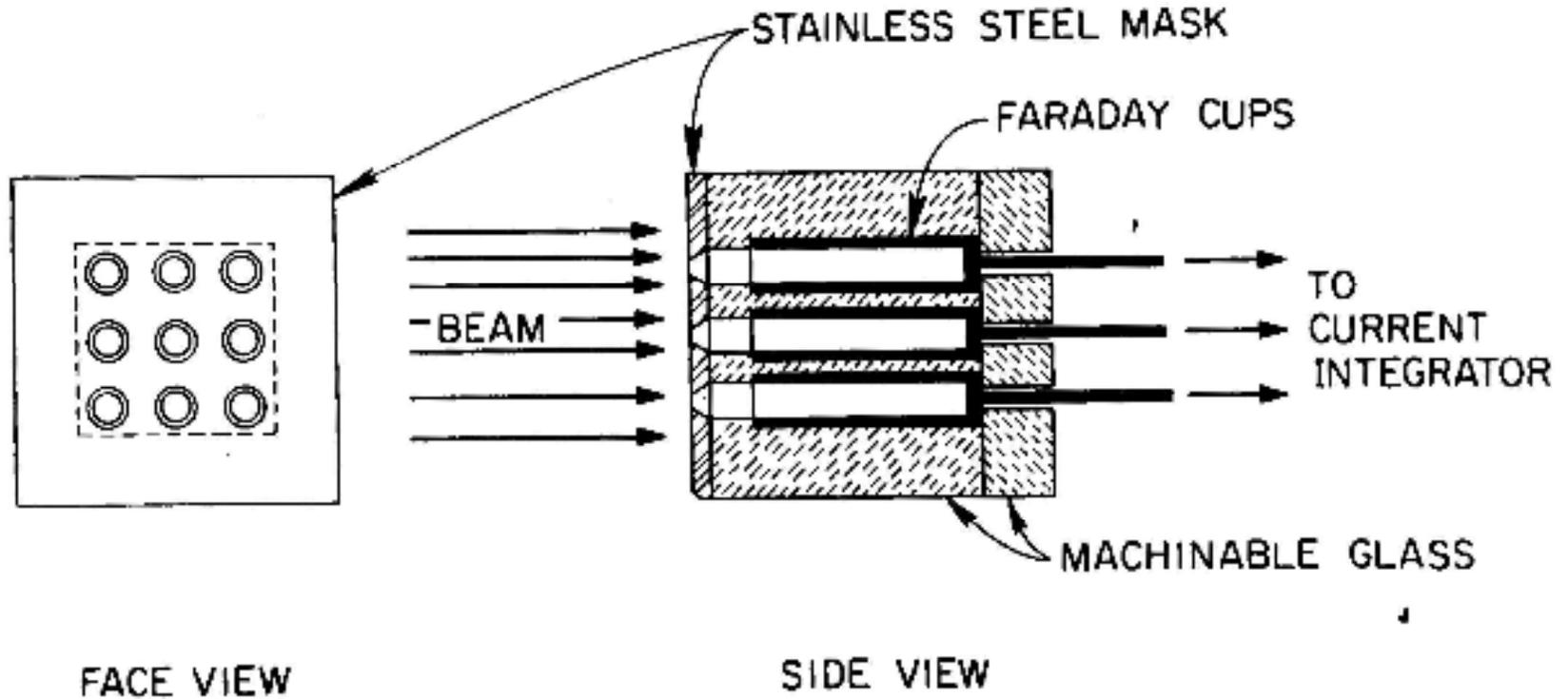


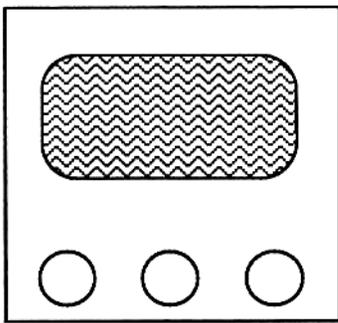
Between filament and platinum disk there is about keV potential to accelerate electrons to bombard the platinum disk, this is the way to heat the stage where the TEM foil sits. Cooling is achieved by running liquid nitrogen through cooling channel at a fixed rate. Temperature control is achieved through control of filament current and electron accelerating voltage.



# ORNL Irradiation Stage

ORNL-DWG 79-11623R



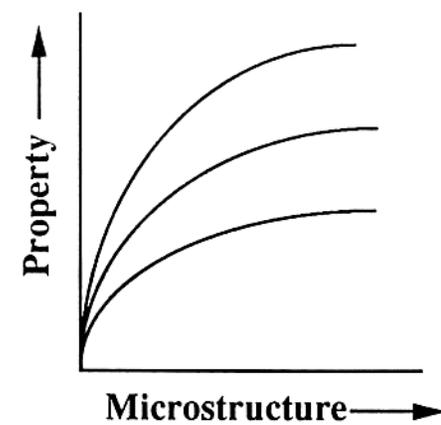


## Deposition parameters

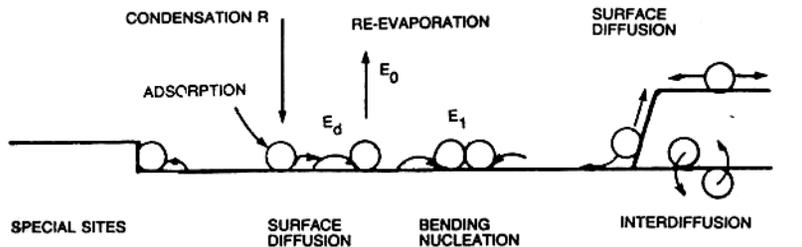
- specie
- rate
- gas pressure
- bombardment flux, energy
- angle
- number of atoms/cluster

## Properties

- hardness
- toughness
- ductility
- wear
- corrosion
- oxidation
- resistivity



# Ion Beam Assisted Deposition



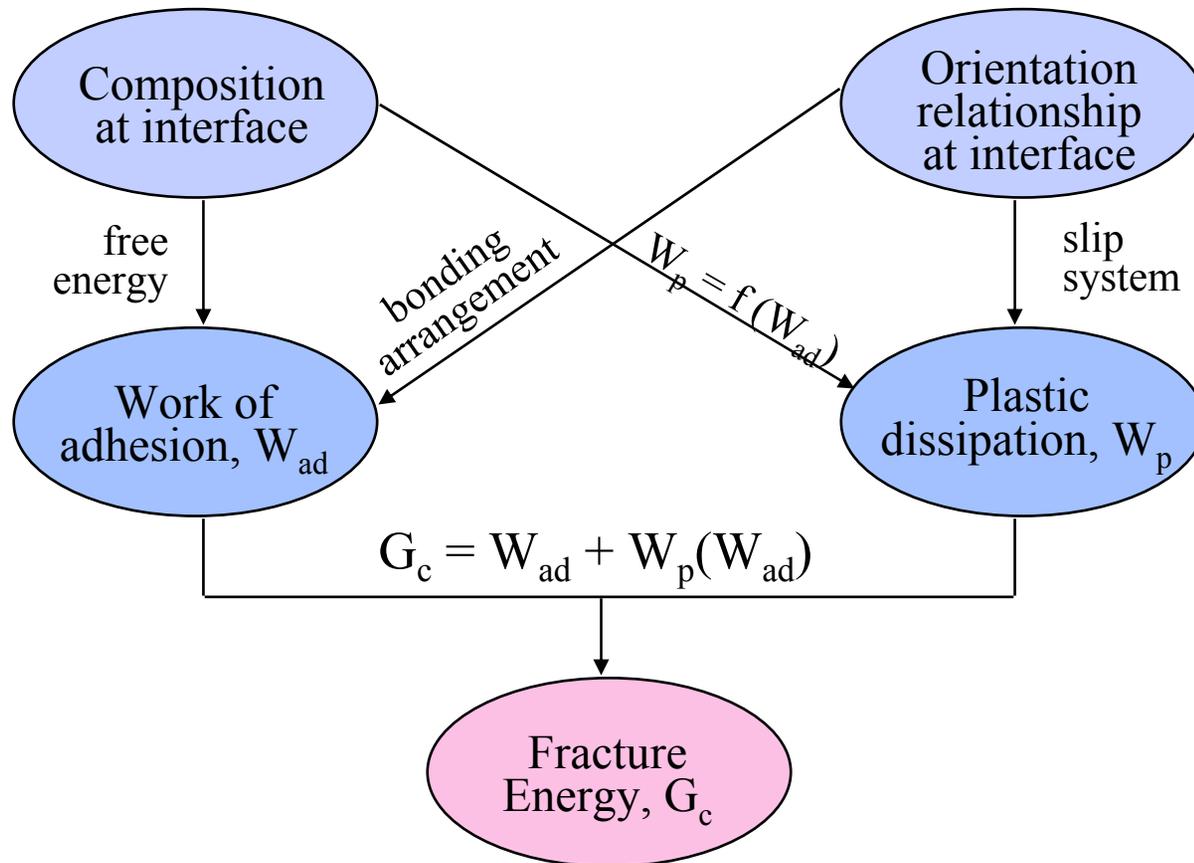
## Surface Processes

- condensation
- re-evaporation
- mobility
- shadowing
- clustering
- relaxation

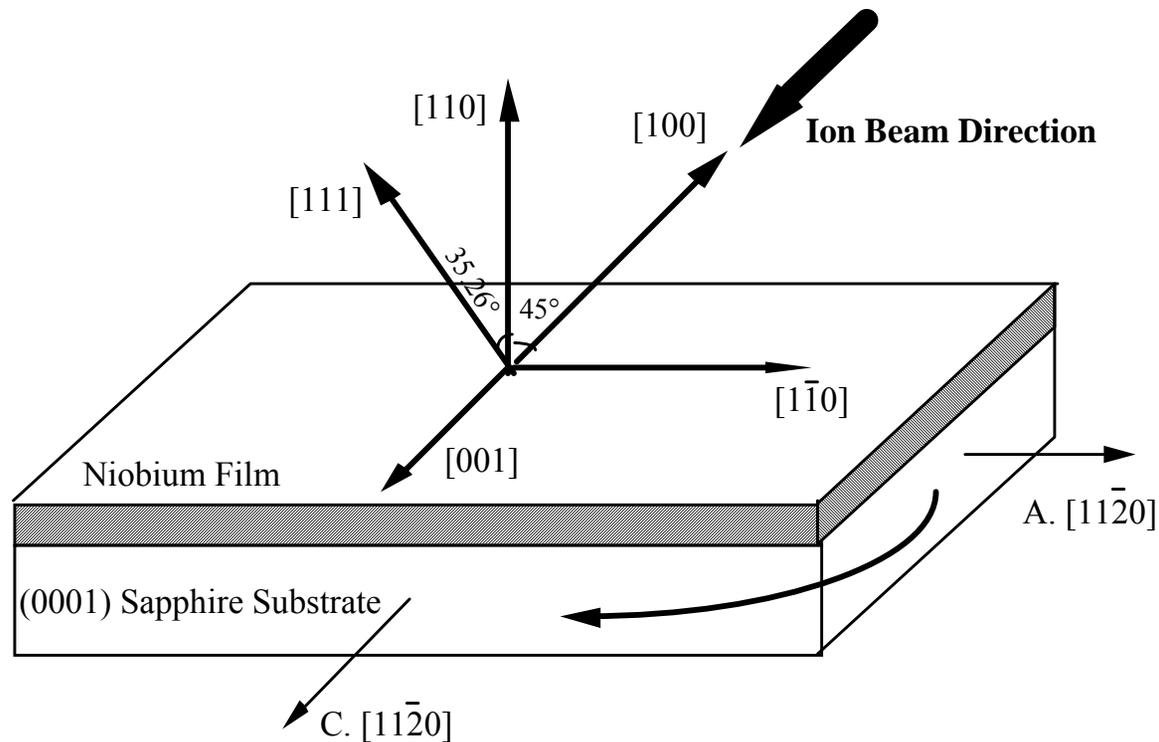
## Microstructure

- density
- topography
- grain size, morphology
- crystallinity
- texture
- residual stress
- interface structure

# Approach for controlling the interface fracture energy using Ion Beam Assisted Deposition (IBAD)



# Control of orientation relationship at Nb-sapphire interface by IBAD



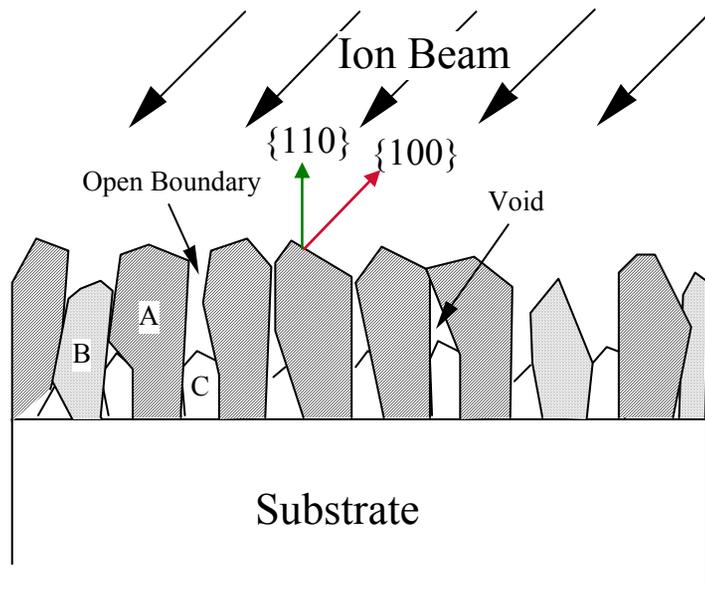
Orientation Relationships Between Niobium Film and Sapphire Substrate

A.  $(110) \parallel (0001)$   $[110] \parallel [11\bar{2}0]$

C.  $(110) \parallel (0001)$   $[001] \parallel [11\bar{2}0]$



# Schematic of Nb film growth under energetic ion bombardment

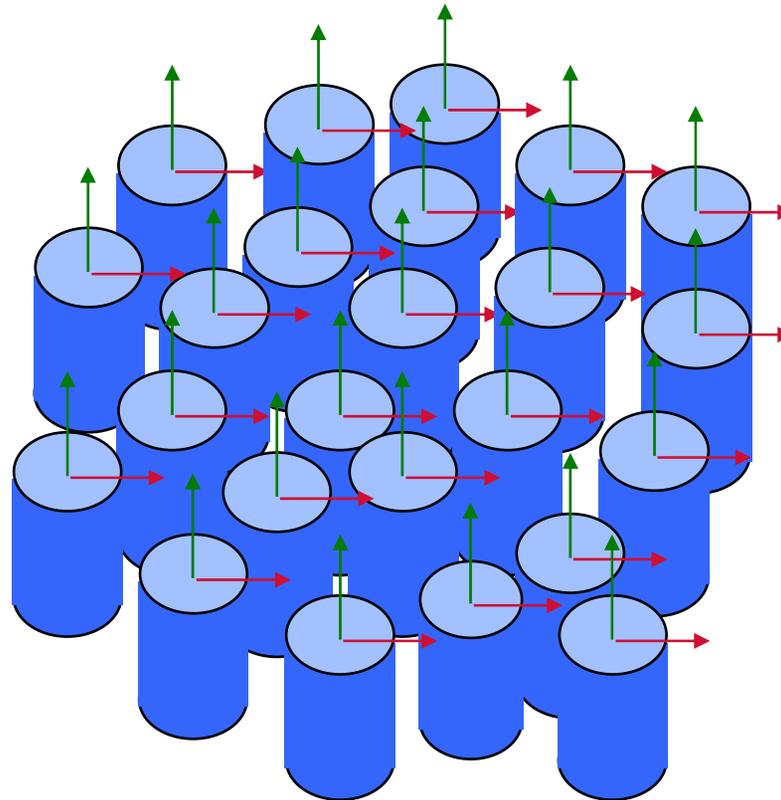


[100] channeling direction  
for niobium

- grain A has the easy channeling direction aligned with ion beam
- grain B and C are randomly oriented grains



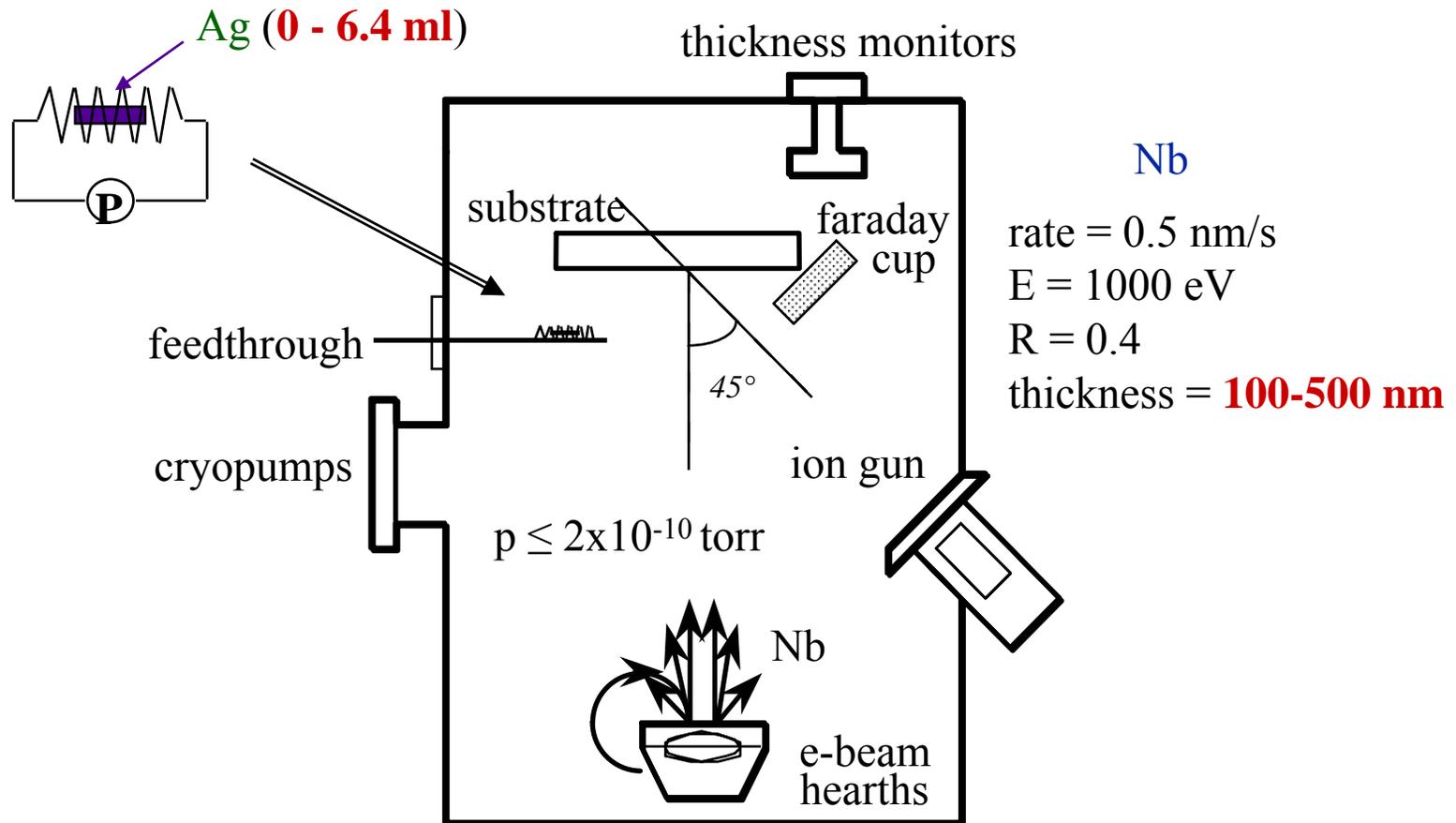
# Control of in-plane texture in Nb in IBAD through preferential sputtering and ion channeling



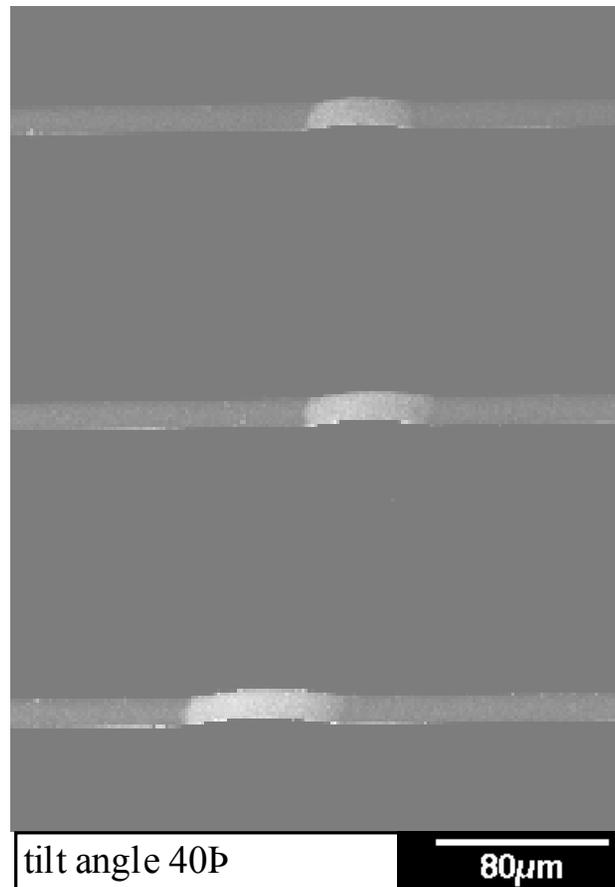
In-plane texture



# Deposition of Ag and Nb onto Sapphire



# Buckling of patterned lines of PVD Nb on sapphire



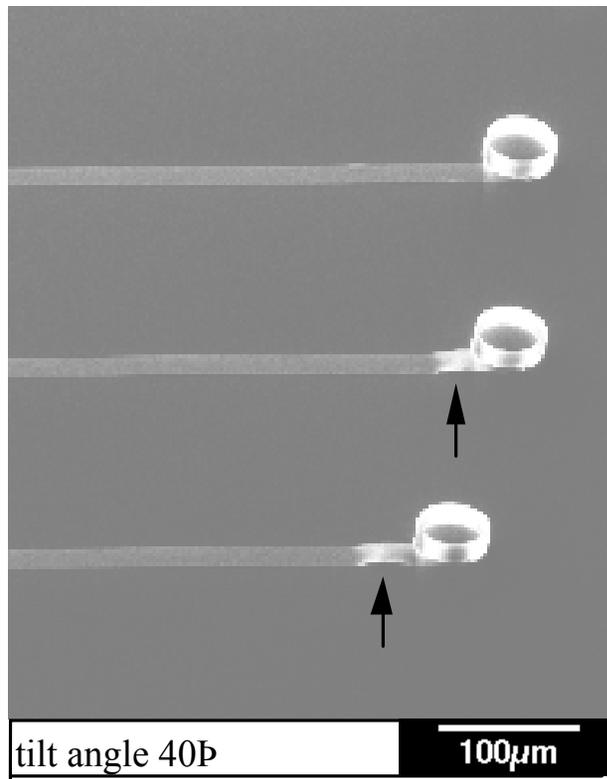
Ag: 3.0 ml

$$G_c = 0.78 \text{ J/m}^2$$

Nb film must be  
in compression

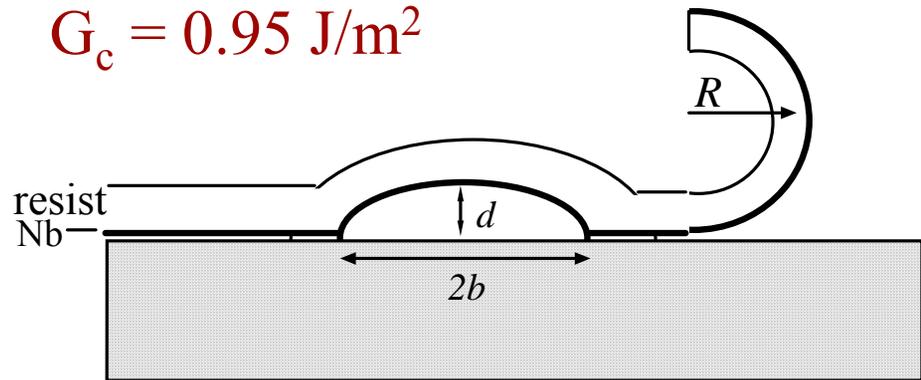


# Curling of patterned lines of PVD Nb film/photoresist on sapphire



Ag: 2.1 ml

$$G_c = 0.95 \text{ J/m}^2$$



A stress gradient exists in the film/photoresist bilayer

# Dispersion strengthening through IBAD

- Follstaedt, Knapp and Barbour developed use of ion assisted deposition dispersion strengthening.

Motivation:  $\tau = 2Gb/L$  and  $f \propto (\delta/L)^3$

20% O in Al as  $Al_2O_3$ , synthesized by ECR plasma implantation resulted in average a film hardness of  $\sim 3$  GPa.

- For small ( $\sim 1$  nm), ordered precipitates, the expected strength is on the order of 5 GPa.
- Advantages over ion implantation: no depth limit and much quicker.

# What we need to know

## Irradiation of multilayered structures

- Layer mixing behavior at high temperatures
  - role of thermodynamics ( $\Delta H_{\text{mix}}$ ,  $\Delta H_{\text{coh}}$ )
  - role of ballistic processes and RED
- Phase formation/stability under high temperature irradiation
- Layer thickness limits
- Dose, dose rate dependence of mixing, phase stability

## Synthesis of multilayered structures

- Very fine layers vs. thicker layers in hardened state
- Dispersion strengthened structures
- What about dispersion strengthened multilayer structures?

